## 20A User-Configurable Quad-Phase Buck Converter

## General Description

The MAX77812 is a quad-phase high-efficiency stepdown (buck) converter capable of delivering up to 20A of maximum current. Programmable startup/shutdown sequence and user-selectable phase configurations make the MAX77812 ideal for powering the latest generations of processors. With high-efficiency and small solution size, the MAX77812 is optimized for space constrained single-cell battery powered applications.
The MAX77812 uses an adaptive on-time PWM control scheme and it has SKIP and low-power SKIP modes for improved light-load efficiency. A programmable current limit reduces the overall solution footprint by optimizing inductors size. Differential sensing provides high output voltage accuracy, while enhanced transient response (ETR) allows fast output voltage adjustments to load transients. Programmable soft-start/stop and ramp-up/down slew rate provides control over an inrush current as the regulator transitions between operating states.
A 3.4 MHz high-speed $\mathrm{I}^{2} \mathrm{C}$ or 30 MHz SPI interface with dedicated logic inputs provide full configurability and control for system power optimization.
The MAX77812 is available in $3.408 \mathrm{~mm} \times 3.368 \mathrm{~mm}$, 64-bump 0.4 mm pitch wafer-level package (WLP).

## Benefits and Features

- 20A Maximum Output Current (5A per Phase)
- $\mathrm{V}_{\mathrm{IN}}$ Range: 2.5 V to 5.5 V
- Vout Range: 0.250 V to 1.525 V with 5 mV Steps
- $\pm 0.5 \%$ Initial Output Accuracy with Differential Sensing
- 5 User-Selectable Phase Configurations
- $91 \%$ Peak Efficiency $\left(\mathrm{V}_{\mathrm{IN}}=3.8 \mathrm{~V}, \mathrm{~V}_{\text {OUT }}=1.1 \mathrm{~V}\right)$
- Auto (SKIP/PWM) and Forced PWM Modes
- Enhanced Load Transient Response
- Programmable Ramp-Up/Down Slew Rates
- Programmable Startup/Shutdown Sequence
- UVLO, Short-Circuit, and Thermal Protections
- 2 User-Programmable General-Purpose Inputs
- 3.4 MHz High Speed ${ }^{2} \mathrm{C}$ and 30 MHz SPI Interface
- $3.408 \mathrm{~mm} \times 3.368 \mathrm{~mm}$, 64-Bump WLP Package


## Applications

- CPU/GPU, FPGAs, and DSPs Power Supply
- AR/VR Headsets and Game Consoles
- Li-ion Battery Powered Equipment
- Space Constrained Portable Electronics

Ordering Information appears at end of data sheet.

## Typical Application Circuit



19-8541; Rev 12; 10/22

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SYS, VIO to AGND................................................. 0.3 V to +6.0 V
DGND to AGND...................................................-0.3V to +0.3V
SCL, SDA/MOSI, MISO, SCS, IRQB, CE, EN, LPM, GPIO, GPI1, WDTRSTB_IN to DGND..................... - 0.3 V to ( $\mathrm{V}_{\mathrm{VIO}}+0.3 \mathrm{~V}$ )
PH_CFG0, PH_CFG1, PH_CFG2,

LX1/2/3/4 to PGNDx
-0.3 V to $\left(\mathrm{V}_{\mathrm{IN}}+0.3 \mathrm{~V}\right)$
LX1/2/3/4 to PGNDx (Pulsed <10ns Voltage)......-3.0V to +7.0 V
PGND1/2/3/4 to AGND $\qquad$ -0.3 V to +0.3 V SNS1P, SNS2P, SNS3P, SNS4P to AGND ..-0.3V to ( $\mathrm{V}_{\mathrm{IN}}+0.3 \mathrm{~V}$ ) SNS1N, SNS2N, SNS3N, SNS4N to AGND........-0.3V to +0.3 V Continuous Power Dissipation at $\mathrm{T}_{\mathrm{A}}=+70^{\circ} \mathrm{C}$ (derate $26.17 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$ above $+70^{\circ} \mathrm{C}$ ) .2094mW
Junction Temperature ..... $+150^{\circ} \mathrm{C}$
Storage Temperature Range

$65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Soldering Temperature (reflow)
$+260^{\circ} \mathrm{C}$

Note 1: LXx node has internal clamp diodes to PGNDx and INx. Applications that give forward bias to these diodes should ensure that the total power loss does not exceed the power dissipation limit of IC package.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

## Recommended Operating Conditions

| PARAMETER | SYMBOL | CONDITION <br> RANGE | UNITS |  |
| :--- | :---: | :--- | :---: | :---: |
| Input Voltage Range | $\mathrm{V}_{\text {IN }}$ |  | 2.5 to 5.5 | V |
| Output Current Range | IOUT | For continuous operation at 5 A (per phase), the junction <br> temperature $\left(\mathrm{T}_{\mathrm{J}}\right)$ is limited to $+115^{\circ} \mathrm{C}$. If the junction <br> temperature is higher than $+115^{\circ} \mathrm{C}$, the expected <br> lifetime at 5 A continuous operation is reduced | 0 to 5 | A |
| Junction <br> Range |  |  | -40 to +125 | ${ }^{\circ} \mathrm{C}$ |

Note: These limits are not guaranteed.

## Package Thermal Characteristics (Note 2)

WLP
Junction-to-Ambient Thermal Resistance ( $\theta_{\mathrm{JA}}$ ) ....... $33.2^{\circ} \mathrm{C} / \mathrm{W}$

Note 2: Package thermal resistances were obtained using the method described in JEDEC specification JESD51-7, using a four-layer board. For detailed information on package thermal considerations, refer to www.maximintegrated.com/thermal-tutorial.

## Electrical Characteristics

## Top-Level Electrical Characteristics

$\left(\mathrm{V}_{\mathrm{SYS}}=\mathrm{V}_{\mathrm{INx}}=+3.8 \mathrm{~V}, \mathrm{~V}_{\mathrm{VIO}}=+1.8 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=\mathrm{T}_{\mathrm{J}}=-40^{\circ} \mathrm{C}\right.$ to $+125^{\circ} \mathrm{C}$, typical values are at $\left.\mathrm{T}_{\mathrm{A}}=\mathrm{T}_{\mathrm{J}}=+25^{\circ} \mathrm{C}\right)$

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| GLOBAL INPUT SUPPLY |  |  |  |  |  |  |
| Operating Voltage Range | $\mathrm{V}_{\text {SYS }}$ |  | 2.5 |  | 5.5 | V |
| Shutdown Supply Current | ISHDN | $\mathrm{CE}=$ low, $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ |  | 2 | 5 | $\mu \mathrm{A}$ |
| Standby Current | IstBy | $\begin{aligned} & C E=\text { high and all outputs are off, } \\ & \mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C} \end{aligned}$ |  | 25 |  | $\mu \mathrm{A}$ |

## Electrical Characteristics (continued)

## Top-Level Electrical Characteristics (continued)

$\left(\mathrm{V}_{\mathrm{SYS}}=\mathrm{V}_{\text {INx }}=+3.8 \mathrm{~V}, \mathrm{~V}_{\mathrm{VIO}}=+1.8 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=\mathrm{T}_{\mathrm{J}}=-40^{\circ} \mathrm{C}\right.$ to $+125^{\circ} \mathrm{C}$, typical values are at $\left.\mathrm{T}_{\mathrm{A}}=\mathrm{T}_{\mathrm{J}}=+25^{\circ} \mathrm{C}\right)$

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| No Load Supply Current in Low Power Skip Mode | lLP_SKIP1 | 4-phase configuration (no switching) |  | 120 |  | $\mu \mathrm{A}$ |
|  | ILP_SKIP2 | 3 + 1-phase configuration (no switching) |  | 190 |  |  |
|  | ILP_SKIP3 | $2+2$-phase configuration (no switching) |  | 190 |  |  |
|  | ILP_SKIP4 | $2+1$ + 1-phase configuration (no switching) |  | 265 |  |  |
|  | lLP_SKIP5 | $1+1+1$ + 1-phase configuration (no switching) |  | 340 | 510 |  |
| No Load Supply Current in Skip Mode | ${ }^{\text {ISKIP1 }}$ | 4-phase configuration (no switching) |  | 150 |  | $\mu \mathrm{A}$ |
|  | ISKIP2 | $3+1$-phase configuration (no switching) |  | 250 |  |  |
|  | ISKIP3 | $2+2$-phase configuration (no switching) |  | 250 |  |  |
|  | ISKIP4 | $2+1$ + 1-phase configuration (no switching) |  | 350 |  |  |
|  | ISKIP5 | 1+1+1+1-phase configuration (no switching) |  | 460 | 690 |  |
| No Load Supply Current in Skip Mode with ETR | ISKIP_ETR1 | 4-phase configuration (no switching, ETR enabled) |  | 180 |  | $\mu \mathrm{A}$ |
|  | ISKIP_ETR2 | $3+1$-phase configuration (no switching, ETR enabled) |  | 310 |  |  |
|  | ISKIP_ETR3 | $2+2$-phase configuration (no switching, ETR enabled) |  | 310 |  |  |
|  | ISKIP_ETR4 | $2+1+1$-phase configuration (no switching, ETR enabled) |  | 440 |  |  |
|  | ISKIP_ETR5 | $1+1+1+1$-phase configuration (no switching, ETR enabled) |  | 580 | 870 |  |
| VSYS UNDERVOLTAGE LOCKOUT |  |  |  |  |  |  |
| $\mathrm{V}_{\text {SYS }}$ Undervoltage Lockout Threshold | VUVLO_R | $\mathrm{V}_{\text {SYS }}$ rising | 2.375 | 2.50 | 2.625 | V |
|  | VUVLO_F | $\mathrm{V}_{\text {SYS }}$ falling (default) |  | 2.15 |  |  |
| THERMAL PROTECTION |  |  |  |  |  |  |
| Thermal Protection Threshold | TSHDN | $\mathrm{T}_{\mathrm{J}}$ rising, $15^{\circ} \mathrm{C}$ hysteresis |  | 165 |  | ${ }^{\circ} \mathrm{C}$ |
| Thermal Interrupt at $120^{\circ} \mathrm{C}$ | $\mathrm{T}_{\text {INT120 }}$ | $\mathrm{T}_{\mathrm{J}}$ rising, $15^{\circ} \mathrm{C}$ hysteresis |  | 120 |  | ${ }^{\circ} \mathrm{C}$ |
| Thermal Interrupt at $140^{\circ} \mathrm{C}$ | $\mathrm{T}_{\text {INT140 }}$ | $\mathrm{T}_{\mathrm{J}}$ rising, $15^{\circ} \mathrm{C}$ hysteresis |  | 140 |  | ${ }^{\circ} \mathrm{C}$ |

## Electrical Characteristics (continued)

## Top-Level Electrical Characteristics (continued)

$\left(\mathrm{V}_{\mathrm{SYS}}=\mathrm{V}_{\text {INx }}=+3.8 \mathrm{~V}, \mathrm{~V}_{\mathrm{VIO}}=+1.8 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=\mathrm{T}_{\mathrm{J}}=-40^{\circ} \mathrm{C}\right.$ to $+125^{\circ} \mathrm{C}$, typical values are at $\left.\mathrm{T}_{\mathrm{A}}=\mathrm{T}_{\mathrm{J}}=+25^{\circ} \mathrm{C}\right)$

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| LOGIC AND CONTROL INPUTS |  |  |  |  |  |  |
| Input Low Level | $\mathrm{V}_{\text {IL }}$ | PH_CFG0, PH_CFG1, PH_CFG2, I2C_SPI_SEL, $\mathrm{V}_{\mathrm{SYS}} \leq 5.5 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ |  |  | 0.4 | V |
|  |  | CE, EN, LPM, GPIO, GPI1, WDTRSTB_IN, $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ |  |  | $\begin{aligned} & 0.3 \mathrm{x} \\ & \mathrm{~V}_{\mathrm{VIO}} \end{aligned}$ |  |
| Input High Level | $\mathrm{V}_{\mathrm{IH}}$ | PH_CFG0, PH_CFG1, PH_CFG2, I2C_SPI_SEL, $\mathrm{V}_{\mathrm{SYS}} \leq 5.5 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ | 1.2 |  |  | V |
|  |  | CE, EN, LPM, GPIO, GPI1, WDTRSTB_IN, $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ | $\begin{aligned} & 0.7 \mathrm{x} \\ & \mathrm{~V}_{\mathrm{VIO}} \end{aligned}$ |  |  |  |
| Logic Input Leakage Current | ILK | $\begin{aligned} & \text { PH_CFG0, PH_CFG1, PH_CFG2, } \\ & 12 \mathrm{C}=\text { SPI_SEL, } \mathrm{V}_{\text {SYS }}^{\circ}=5.5 \mathrm{~V}, \\ & \mathrm{CE}=1.8 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C} \end{aligned}$ | -1 | +0.001 | +1 | $\mu \mathrm{A}$ |
|  |  | CE, EN, LPM, GPIO, GPI1, $\mathrm{CE}=1.8 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ | -1 | +0.001 | +1 |  |
|  |  | $\begin{aligned} & \text { PH_CFG0, PH_CFG1, PH_CFG2, } \\ & 12 \mathrm{C}=\text { SPI_SEL, } \mathrm{V}_{\text {SYS }}^{\circ}=5.5 \mathrm{~V}, \\ & \mathrm{CE}=1.8 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+85^{\circ} \mathrm{C}(\text { Note } 4) \end{aligned}$ |  | 0.1 |  |  |
|  |  | CE, EN, LPM, GPIO, GPI1, $\mathrm{CE}=1.8 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+85^{\circ} \mathrm{C}$ (Note 4) |  | 0.1 |  |  |
| $\overline{\mathrm{IRQ}}$ Output Low Voltage | V OL | $\mathrm{I}_{\text {SINK }}=1 \mathrm{~mA}$ |  |  | 0.4 | V |
| $\overline{\mathrm{IRQ}}$ Output High Leakage | ILK_OH | $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ | -1 | 0.001 | +1 | $\mu \mathrm{A}$ |
|  |  | $\mathrm{T}_{\mathrm{A}}=+85^{\circ} \mathrm{C}$ (Note 4) |  | 0.1 |  |  |
| INTERNAL PULL-UP/DOWN RESISTANCE |  |  |  |  |  |  |
| WDTRSTB_IN Pullup Resistance | RPU | Pullup resistance to VIO | 400 | 800 | 1600 | k $\Omega$ |
| GPI0, GPI1, EN, LPM Pulldown Resistance | RPD | Pulldown resistance to DGND | 400 | 800 | 1600 | k $\Omega$ |

## Electrical Characteristics (continued)

## Quad-Phase Buck Electrical Characteristics

$\left(\mathrm{V}_{\mathrm{SYS}}=\mathrm{V}_{\text {INx }}=+3.8 \mathrm{~V}, \mathrm{~V}_{\text {OUTX }}=0.85 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=\mathrm{T}_{\mathrm{J}}=-40^{\circ} \mathrm{C}\right.$ to $+125^{\circ} \mathrm{C}$, typical values are at $\mathrm{T}_{\mathrm{A}}=\mathrm{T}_{\mathrm{J}}=+25^{\circ} \mathrm{C}$

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| POWER SUPPLY |  |  |  |  |  |  |
| Input Voltage Range | $\mathrm{V}_{\text {INx }}$ |  | 2.5 |  | $\mathrm{V}_{\text {SYS }}$ | V |
| Output Voltage Range | V OUT | Programmable with 8-bit resolution, $5 \mathrm{mV} / \mathrm{LSB}$ | 0.25 |  | 1.525 | V |
| DC OUTPUT VOLTAGE ACCURACY |  |  |  |  |  |  |
| Output Voltage Accuracy | $\mathrm{V}_{\text {ACC_INIT }}$ | Force PWM mode, differential remote sensing, $\mathrm{V}_{\text {OUT }} \geq 0.65 \mathrm{~V}$, I IUT $=0 \mathrm{~mA}$, $C_{\text {OUT (EFF) }}=64 \mu \mathrm{~F}$, $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ | -0.5 |  | +0.5 | \% |
|  |  | Force PWM mode, differential remote sensing, $0.45 \mathrm{~V} \leq \mathrm{V}_{\text {OUT }}<0.6 \mathrm{~V}$, I IUT $=$ OmA, Cout(EFF) $=64 \mu \mathrm{~F}$, $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ | -6 |  | +6 | mV |
| Load Regulation |  | Forced PWM mode, differential remote sensing, IOUT $=0 \mathrm{~A}$ to 5 A , Cout (EFF) $=64 \mu \mathrm{~F}$ (Note 5) | -0.001 |  |  | V/A |
| Line Regulation |  | Forced PWM mode, differential remote sensing, $\mathrm{V}_{\mathrm{INx}}=2.5 \mathrm{~V}$ to $5.5 \mathrm{~V}, \mathrm{~V}_{\text {OUT }}$ <br> $=$ Default, IOUT $=0 \mathrm{~mA}$, <br> $C_{\text {OUT(EFF) }}=64 \mu \mathrm{~F}$ | -0.005 |  | +0.005 | V/V |
| AC OUTPUT VOLTAGE ACCURACY |  |  |  |  |  |  |
| Line Transient Response | $\mathrm{V}_{\text {DROOP }}$ | $\begin{aligned} & \mathrm{V}_{\text {INx }}=3.4 \mathrm{~V} \text { to } 2.9 \mathrm{~V} \text { to } 3.4 \mathrm{~V} \text {, } \\ & \mathrm{t}_{\text {RISE }}=\mathrm{t}_{\text {FALL }}=10 \mu \mathrm{~s}, \mathrm{~V}_{\text {OUT }} \\ & =1.1 \mathrm{~V}, \mathrm{I}_{\mathrm{OUT}}=2 \mathrm{~A}, \\ & \mathrm{~L}=220 \mathrm{nH}(\mathrm{DCR}=9 \mathrm{~m} \Omega), \\ & \left.\mathrm{C}_{\text {OUT }} \mathrm{EFF}\right)=16 \mu \mathrm{~F} \\ & (\mathrm{ESR}=5 \mathrm{~m} \Omega, \mathrm{ESL}=300 \mathrm{pH}) \\ & \text { per phase }(\text { Note } 5) \end{aligned}$ |  | 15 |  | mV |
| Load Transient Response | $V_{\text {DROOP }}$ | SKIP/PWM mode, differential remote sensing, $\mathrm{V}_{\text {OUT }}=$ <br> 1.1 V, I OUT $=0.1 \mathrm{~A}$ <br> to $4 \mathrm{~A}(100 \mathrm{~A} / \mu \mathrm{s}), \mathrm{L}=220 \mathrm{nH}$ <br> $(\mathrm{DCR}=9 \mathrm{~m} \Omega), \operatorname{COUT}(\mathrm{EFF})=$ <br> $16 \mu \mathrm{~F}(\mathrm{ESR}=5 \mathrm{~m} \Omega$, <br> ESL = 300pH) per Phase <br> (Note 5) |  | 45 |  | mV |

## Electrical Characteristics (continued)

## Quad-Phase Buck Electrical Characteristics (continued)

$\left(\mathrm{V}_{\mathrm{SYS}}=\mathrm{V}_{\text {INx }}=+3.8 \mathrm{~V}, \mathrm{~V}_{\text {OUTx }}=0.85 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=\mathrm{T}_{\mathrm{J}}=-40^{\circ} \mathrm{C}\right.$ to $+125^{\circ} \mathrm{C}$, typical values are at $\mathrm{T}_{\mathrm{A}}=\mathrm{T}_{\mathrm{J}}=+25^{\circ} \mathrm{C}$

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| RAMP RATE |  |  |  |  |  |  |
| Soft-Start Slew Rate |  | $\begin{aligned} & \text { B_SS_SR[2:0] }=000 \mathrm{~b} \\ & (\text { Note } 6) \end{aligned}$ |  | 1.25 |  | $\mathrm{mV} / \mu \mathrm{s}$ |
|  |  | $\begin{aligned} & \text { B_SS_SR[2:0] }=001 \mathrm{~b} \\ & (\text { Note 6) } \end{aligned}$ |  | 2.5 |  |  |
|  |  | $\begin{aligned} & \text { B_SS_SR[2:0] }=010 \mathrm{~b} \\ & (\text { Note 6) } \end{aligned}$ |  | 5 |  |  |
|  |  | $\begin{aligned} & \text { B_SS_SR[2:0] }=011 \mathrm{~b} \\ & (\text { Note } 6) \end{aligned}$ |  | 10 |  |  |
|  |  | $\begin{aligned} & \text { B_SS_SR[2:0] = 100b } \\ & \text { (default) (Note 6) } \end{aligned}$ |  | 20 |  |  |
|  |  | $\begin{aligned} & \text { B_SS_SR[2:0] }=101 \mathrm{~b} \\ & (\text { Note } 6) \end{aligned}$ |  | 40 |  |  |
|  |  | $\begin{aligned} & \text { B_SS_SR[2:0] = 110b or } \\ & \text { 111b (Note 6) } \end{aligned}$ |  | 60 |  |  |
| Shutdown Slew Rate |  | $\begin{aligned} & \text { B_SD_SR[2:0] }=000 \mathrm{~b} \\ & (\text { Note } 6) \end{aligned}$ |  | 1.25 |  | $\mathrm{mV} / \mathrm{\mu s}$ |
|  |  | $\begin{aligned} & \text { B_SD_SR[2:0] }=001 \mathrm{~b} \\ & (\text { Note 6) } \end{aligned}$ |  | 2.5 |  |  |
|  |  | $\begin{aligned} & \text { B_SD_SR[2:0] = 010b } \\ & \text { (default) }(\text { Note 6) } \end{aligned}$ |  | 5 |  |  |
|  |  | $\begin{aligned} & \text { B_SD_SR[2:0] = 011b } \\ & (\text { Note } 6) \end{aligned}$ |  | 10 |  |  |
|  |  | $\begin{aligned} & \text { B_SD_SR[2:0] }=100 \mathrm{~b} \\ & (\text { Note } 6) \end{aligned}$ |  | 20 |  |  |
|  |  | $\begin{aligned} & \text { B_SD_SR[2:0] }=101 \mathrm{~b} \\ & (\text { Note } 6) \end{aligned}$ |  | 40 |  |  |
|  |  | $\begin{aligned} & \text { B_SD_SR[2:0] = 110b or } \\ & \text { 111b (Note 6) } \end{aligned}$ |  | 60 |  |  |

## Electrical Characteristics (continued)

## Quad-Phase Buck Electrical Characteristics (continued)

$\left(\mathrm{V}_{\mathrm{SYS}}=\mathrm{V}_{\text {INx }}=+3.8 \mathrm{~V}, \mathrm{~V}_{\text {OUTX }}=0.85 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=\mathrm{T}_{\mathrm{J}}=-40^{\circ} \mathrm{C}\right.$ to $+125^{\circ} \mathrm{C}$, typical values are at $\mathrm{T}_{\mathrm{A}}=\mathrm{T}_{\mathrm{J}}=+25^{\circ} \mathrm{C}$

| PARAMETER | SYMBOL | CONDITIONS | MIN TYP | MAX | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: |
| DVS Ramp-Up Slew Rate |  | $\begin{aligned} & \text { B_RU_SR[2:0] }=000 \mathrm{~b} \\ & \text { (Note 6) } \end{aligned}$ | 1.25 |  | $\mathrm{mV} / \mu \mathrm{s}$ |
|  |  | $\begin{aligned} & \text { B_RU_SR[2:0] = 001b } \\ & (\text { Note 6) } \end{aligned}$ | 2.5 |  |  |
|  |  | $\begin{aligned} & \text { B_RU_SR[2:0] }=010 \mathrm{~b} \\ & (\text { Note } 6) \end{aligned}$ | 5 |  |  |
|  |  | $\begin{aligned} & \text { B_RU_SR[2:0] }=011 \mathrm{~b} \\ & \text { (Note 6) } \end{aligned}$ | 10 |  |  |
|  |  | $\begin{aligned} & \text { B_RU_SR[2:0] = } 100 \mathrm{~b} \\ & \text { (default) (Note 6) } \end{aligned}$ | 20 |  |  |
|  |  | B_RU_SR[2:0] = 101b <br> (Note 6) | 40 |  |  |
|  |  | $\begin{aligned} & \text { B_RU_SR[2:0] }=110 \mathrm{~b} \text { or } \\ & \text { 111b (Note 6) } \end{aligned}$ | 60 |  |  |
| DVS Ramp-Down Slew Rate |  | $\begin{aligned} & \text { B_RD_SR[2:0] = 000b } \\ & (\text { Note 6) } \end{aligned}$ | 1.25 |  | $\mathrm{mV} / \mathrm{\mu s}$ |
|  |  | $\begin{aligned} & \text { B_RD_SR[2:0] = 001b } \\ & (\text { Note 6) } \end{aligned}$ | 2.5 |  |  |
|  |  | $\begin{aligned} & \text { B_RD_SR[2:0] = 010b } \\ & \text { (default) (Note 6) } \end{aligned}$ | 5 |  |  |
|  |  | $\begin{aligned} & \text { B_RD_SR[2:0] }=011 \mathrm{~b} \\ & (\text { Note } 6) \end{aligned}$ | 10 |  |  |
|  |  | $\begin{aligned} & \text { B_RD_SR[2:0] }=100 \mathrm{~b} \\ & (\text { Note } 6) \end{aligned}$ | 20 |  |  |
|  |  | $\begin{aligned} & \text { B_RD_SR[2:0] = 101b } \\ & (\text { Note 6) } \end{aligned}$ | 40 |  |  |
|  |  | $\begin{aligned} & \text { B_RD_SR[2:0] = 110b or } \\ & \text { 111b (Note 6) } \end{aligned}$ | 60 |  |  |
| Turn-On Delay Time | ton_DLY1 | From EN signal to LXB switching with bias on (Note 6) | 30 |  | $\mu \mathrm{s}$ |
|  | ton_DLY2 | From EN signal to LXB switching with bias off (Note 5) | 85 |  |  |

## Electrical Characteristics (continued)

## Quad-Phase Buck Electrical Characteristics (continued)

$\left(\mathrm{V}_{\mathrm{SYS}}=\mathrm{V}_{\text {INx }}=+3.8 \mathrm{~V}, \mathrm{~V}_{\text {OUTx }}=0.85 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=\mathrm{T}_{\mathrm{J}}=-40^{\circ} \mathrm{C}\right.$ to $+125^{\circ} \mathrm{C}$, typical values are at $\mathrm{T}_{\mathrm{A}}=\mathrm{T}_{\mathrm{J}}=+25^{\circ} \mathrm{C}$

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| POWER STAGE |  |  |  |  |  |  |
| Maximum Output Current | IOUT(MAX) | RMS current per phase, $\mathrm{V}_{\text {IN }}<3.2 \mathrm{~V}$ (Note 5) |  | 4000 |  | mA |
|  | IOUT(MAX) | RMS current per phase, $3.2 \mathrm{~V} \leq \mathrm{V}_{\mathrm{IN}} \leq 5.5 \mathrm{~V}(\text { Note } 5)$ |  | 5000 |  |  |
| PMOS Peak Current Limit | IPLIM | Mx_ILIM[2:0] = 000b |  | 3000 |  | mA |
|  | IPLIM | Mx_ILIM[2:0] = 001b |  | 3600 |  |  |
|  | IPLIM | Mx_ILIM[2:0] = 010b |  | 4200 |  |  |
|  | IPLIM | Mx_ILIM[2:0] = 011b |  | 4800 |  |  |
|  | IPLIM | Mx_ILIM[2:0] = 100b |  | 5400 |  |  |
|  | IPLIM | $\begin{aligned} & \text { Mx_ILIM[2:0] = 101b } \\ & \text { (default) } \end{aligned}$ | 4800 | 6000 | 7200 |  |
|  | IPLIM | Mx_ILIM[2:0] = 110b |  | 6600 |  |  |
|  | IPLIM | Mx_ILIM[2:0] = 111b | 5200 | 7200 | 9200 |  |
| NMOS Valley Current Limit | IVLIM | Mx_ILIM[2:0] = 000b |  | 2000 |  | mA |
|  | IVLIM | Mx_ILIM[2:0] = 001b |  | 2400 |  |  |
|  | IVLIM | Mx_ILIM[2:0] = 010b |  | 2800 |  |  |
|  | IVLIM | Mx_ILIM[2:0] = 011b |  | 3200 |  |  |
|  | IVLIM | Mx_ILIM[2:0] = 100b |  | 3600 |  |  |
|  | IVLIM | $\begin{aligned} & \text { Mx_ILIM[2:0] = 101b } \\ & \text { (default) } \end{aligned}$ | 3200 | 4000 | 4800 |  |
|  | IVLIM | Mx_ILIM[2:0] = 110b |  | 4400 |  |  |
|  | IVLIM | Mx_ILIM[2:0] = 111b | 3800 | 4800 | 5800 |  |
| NMOS Negative Current Limit | INLIM | Per phase | -2000 | -1500 | -1000 | mA |
| Switching Frequency | ${ }_{\text {f }}$ W | $\mathrm{V}_{\text {OUT }}=$ default, Forced PWM mode | 1.6 | 2.0 | 2.8 | MHz |
| High-Side PMOS On-Resistance | $\mathrm{R}_{\text {DSON(PMOS }}$ | INx to LXX, $\mathrm{l}_{\text {LXx }}=-150 \mathrm{~mA}$ |  | 32 | 70 | $\mathrm{m} \Omega$ |
| Low-Side NMOS On-Resistance | $\mathrm{R}_{\text {DSON(NMOS }}$ ( | $\begin{aligned} & \text { LXx to PGNDx, } \mathrm{I}_{\mathrm{LXx}}= \\ & 150 \mathrm{~mA} \end{aligned}$ |  | 15 | 29 | $\mathrm{m} \Omega$ |
| LX Active Discharge Resistance | $\mathrm{R}_{\text {AD_LX }}$ | Resistance from LXx to PGNDx, per phase, output disabled |  | 100 | 200 | $\Omega$ |

## Electrical Characteristics (continued)

Quad-Phase Buck Electrical Characteristics (continued)
$\left(\mathrm{V}_{\mathrm{SYS}}=\mathrm{V}_{\text {INx }}=+3.8 \mathrm{~V}, \mathrm{~V}_{\text {OUTX }}=0.85 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=\mathrm{T}_{\mathrm{J}}=-40^{\circ} \mathrm{C}\right.$ to $+125^{\circ} \mathrm{C}$, typical values are at $\mathrm{T}_{\mathrm{A}}=\mathrm{T}_{\mathrm{J}}=+25^{\circ} \mathrm{C}$

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| LX Leakage Current | ILKG_LX | $\begin{aligned} & \mathrm{V}_{\mathrm{LXx}}=0 \mathrm{~V} \text { or } 5.5 \mathrm{~V}, \\ & \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C} \end{aligned}$ | -1 | 0.1 | +1 | $\mu \mathrm{A}$ |
|  | ILKG_LX | $\begin{aligned} & \mathrm{V}_{\mathrm{LXX}}=0 \mathrm{~V} \text { or } 5.5 \mathrm{~V}, \\ & \mathrm{~T}_{\mathrm{A}}=+85^{\circ} \mathrm{C}(\text { Note } 4) \end{aligned}$ |  | 1 |  |  |
| Nominal Inductance | $\mathrm{L}_{\text {NOM }}$ | (Note 5) |  | 220 |  | nH |
| Minimum Effective Output Capacitance | Cout(EFF_MIN) | $\begin{aligned} & 0 \mu \mathrm{~A}<\mathrm{I}_{\text {OUT }}<5000 \mathrm{~mA} \text { per } \\ & \text { phase (Note 5) } \end{aligned}$ |  | 16 |  | $\mu \mathrm{F}$ |
| EFFICIENCY AND OUTPUT RIPPLE |  |  |  |  |  |  |
| Peak Efficiency | $\eta_{\text {PK }}$ | $\begin{aligned} & \mathrm{L}=220 \mathrm{nH}(\mathrm{DCR}=9 \mathrm{~m} \Omega), \\ & \mathrm{COUT}(\mathrm{EFF})=16 \mu \mathrm{~F} \\ & (\mathrm{ESR}=5 \mathrm{~m} \Omega, \mathrm{ESL}=300 \mathrm{pH}) \\ & \text { per Phase }(\text { Note } 5) \end{aligned}$ |  | 90 |  | \% |
| Heavy Load Efficiency | $\eta_{H E A V Y}$ | $\begin{aligned} & \text { loUT }=5 \mathrm{~A}, \mathrm{~L}=220 \mathrm{nH} \\ & (\mathrm{DCR}=9 \mathrm{~m} \Omega), \mathrm{COUT}(\mathrm{EFF})= \\ & 16 \mu \mathrm{~F}(\mathrm{ESR}=5 \mathrm{~m} \Omega, \\ & \text { ESL }=300 \mathrm{pH}) \text { per Phase } \\ & \text { (Note 5) } \end{aligned}$ |  | 75 |  | \% |
| Skip Mode Output Ripple | $\mathrm{V}_{\text {RIP_SKIP }}$ | Skip mode, IOUT $=0.1 \mathrm{~A}$, $\mathrm{L}=220 \mathrm{nH}(\mathrm{DCR}=9 \mathrm{~m} \Omega)$, $\mathrm{C}_{\mathrm{OUT}(\mathrm{EFF})}=16 \mu \mathrm{~F}(\mathrm{ESR}$ $=5 \mathrm{~m} \Omega$, $\mathrm{ESL}=300 \mathrm{pH}$ ) per phase (Note 7) |  | 10 |  | $m V_{\text {P-P }}$ |
| FPWM Mode Output Ripple | VRIP_FPWM | Forced PWM mode, differential remote sensing, IOUT $=0.1 \mathrm{~A}, \mathrm{~L}=220 \mathrm{nH}$ (DCR = 9m $\Omega$ ), COUT(EFF) $=16 \mu \mathrm{~F}(\mathrm{ESR}=5 \mathrm{~m} \Omega$, ESL = 300 pH ) per phase (Note 7) |  | 5 |  | $\mathrm{mV} \mathrm{P}_{\text {-P }}$ |
| POWER OK COMPARATOR |  |  |  |  |  |  |
| Output POK Trip Level |  | Rising threshold |  | 90 |  | \% |
|  |  | Falling threshold |  | 85 | 90 |  |

## Electrical Characteristics (continued)

## $I^{2} \mathrm{C}$ Electrical Characteristics

$\left(\mathrm{V}_{\mathrm{SYS}}=\mathrm{V}_{\text {INx }}=+3.8 \mathrm{~V}, \mathrm{~V}_{\mathrm{VIO}}=+1.8 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=\mathrm{T}_{\mathrm{J}}=-40^{\circ} \mathrm{C}\right.$ to $+125^{\circ} \mathrm{C}$, typical values are at $\left.\mathrm{T}_{\mathrm{A}}=\mathrm{T}_{\mathrm{J}}=+25^{\circ} \mathrm{C}\right)$

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| POWER SUPPLY |  |  |  |  |  |  |
| VIO Supply Voltage Range | $\mathrm{V}_{\mathrm{VIO}}$ |  | 1.65 | 1.8 | $\mathrm{V}_{\text {SYS }}$ | V |
| VIO Dynamic Supply Current | $\mathrm{I}_{\mathrm{VIO}}$ | $\mathrm{f}_{\text {SCL }}=\mathrm{f}_{\text {SDA }}=1 \mathrm{MHz}$ |  | 50 |  | $\mu \mathrm{A}$ |
| $\mathrm{V}_{\text {SYS }}$ Dynamic Supply Current | ISYS |  |  | 5 |  | $\mu \mathrm{A}$ |
| SDA AND SCL I/O STAGES |  |  |  |  |  |  |
| SCL, SDA Input High Voltage | $\mathrm{V}_{\mathrm{IH}}$ |  | $0.7 x$ <br> $\mathrm{V}_{\mathrm{VIO}}$ |  |  | V |
| SCL, SDA Input Low Voltage | VIL |  |  |  | $\begin{aligned} & 0.3 \mathrm{x} \\ & \mathrm{~V}_{\mathrm{VIO}} \\ & \hline \end{aligned}$ | V |
| SCL, SDA Input Hysteresis | $\mathrm{V}_{\text {HYS }}$ |  |  | $\begin{aligned} & 0.05 \mathrm{x} \\ & \mathrm{~V}_{\mathrm{VIO}} \\ & \hline \end{aligned}$ |  | V |
| SCL, SDA Input Hysteresis in HS Mode | VHYS_HS |  |  | $\begin{aligned} & 0.1 \mathrm{x} \\ & \mathrm{~V}_{\mathrm{VIO}} \end{aligned}$ |  | V |
| SDA Output Low Voltage | $\mathrm{V}_{\mathrm{OL}}$ | $\mathrm{I}_{\text {SINK }}=5 \mathrm{~mA}$ |  |  | 0.4 | V |
| SCL, SDA Input Capacitance | $\mathrm{Cl}_{1}$ |  |  | 10 |  | pF |
| SCL, SDA Input Leakage Current | ILK | $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ | -1 | +0.001 | +1 | $\mu \mathrm{A}$ |
|  |  | $\mathrm{T}_{\mathrm{A}}=+85^{\circ} \mathrm{C}$ (Note 4) |  | 0.1 |  |  |
| I²C-COMPATIBLE INTERFACE TIMING (STANDARD, FAST AND FAST MODE PLUS) (Note 5) |  |  |  |  |  |  |
| Clock Frequency | $\mathrm{f}_{\text {SCL }}$ |  | 0 |  | 1000 | kHz |
| Bus Free Time between STOP and START Condition | $t_{\text {t }}$ USF |  | 0.5 |  |  | $\mu \mathrm{s}$ |
| Hold Time (REPEATED) START Condition | $\mathrm{t}_{\text {HD_START }}$ |  | 0.26 |  |  | $\mu \mathrm{s}$ |
| SCL Low Period | tLow |  | 0.5 |  |  | $\mu \mathrm{s}$ |
| SCL High Period | $\mathrm{t}_{\mathrm{HIGH}}$ |  | 0.26 |  |  | $\mu \mathrm{s}$ |
| Setup Time REPEATED START Condition | tsu_Start |  | 0.26 |  |  | $\mu \mathrm{s}$ |
| Data Hold Time | $t_{\text {HD_ }}$ DATA | Transmit mode | 0 |  | 450 | ns |
| Data Setup Time | tsu_DATA |  | 50 |  |  | ns |
| SCL, SDA Receiving Rise Time | $t_{\text {R_REV }}$ |  |  |  | 120 | ns |
| SCL, SDA Receiving Fall Time | ${ }^{\text {t }}$ _REV |  | $\begin{gathered} 20 \mathrm{x} \\ \mathrm{~V}_{\mathrm{VIO} / 5.5} \\ \hline \end{gathered}$ |  | 120 | ns |

## Electrical Characteristics (continued)

## $I^{2} \mathrm{C}$ Electrical Characteristics (continued)

$\left(\mathrm{V}_{\mathrm{SYS}}=\mathrm{V}_{\text {INx }}=+3.8 \mathrm{~V}, \mathrm{~V}_{\mathrm{VIO}}=+1.8 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=\mathrm{T}_{\mathrm{J}}=-40^{\circ} \mathrm{C}\right.$ to $+125^{\circ} \mathrm{C}$, typical values are at $\left.\mathrm{T}_{\mathrm{A}}=\mathrm{T}_{\mathrm{J}}=+25^{\circ} \mathrm{C}\right)$

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP MAX | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: |
| SCL, SDA Transmitting Fall Time | $\mathrm{t}_{\text {_ }}$ TRA |  | $\begin{gathered} 20 \mathrm{x} \\ \mathrm{v}_{\mathrm{VIO}} / 5.5 \end{gathered}$ | $120$ | ns |
| Setup Time for STOP Condition | tsu_STOP |  | 0.26 |  | $\mu \mathrm{s}$ |
| Data Valid Time | tVD_DATA |  |  | 450 | ns |
| Data Valid Acknowledge Time | tVD_ACK |  |  | 450 | ns |
| Bus Capacitance | $\mathrm{C}_{\mathrm{B}}$ |  |  | 550 | pF |
| Pulse Width of Suppressed Spikes | tsp |  |  | 50 | ns |
| I2C-COMPATIBLE INTERFACE TIMING (HIGH-SPEED MODE, $\mathrm{C}_{\mathrm{B}}=100 \mathrm{pF}$ ) (Note 5) |  |  |  |  |  |
| Clock Frequency | $\mathrm{f}_{\text {SCL }}$ |  |  | 3.4 | MHz |
| Hold Time (REPEATED) START Condition | $\mathrm{t}_{\text {HD_S }}$ START |  | 160 |  | ns |
| SCL LOW Period | tow |  | 160 |  | ns |
| SCL HIGH Period | $\mathrm{t}_{\mathrm{HIGH}}$ |  | 60 |  | ns |
| Setup Time REPEATED START Condition | tsu_Start |  | 160 |  | ns |
| Data Hold Time | thD_DATA |  | 0 | 70 | ns |
| Data Setup Time | tsu_DATA |  | 10 |  | ns |
| SCL Rise Time | $t_{\text {R_SCL }}$ | $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ | 10 | 40 | ns |
| SCL Rise Time after REPEATED START Condition and after Acknowledge Bit | $t_{\text {R_SCL1 }}$ | $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ | 10 | 40 | ns |
| SCL Fall Time | $t_{\text {F_SCL }}$ | $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ | 10 | 40 | ns |
| SDA Rise Time | $t_{\text {R_SDA }}$ | $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ | 10 | 40 | ns |
| SDA Fall Time | $t_{\text {F_SDA }}$ | $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ |  | 40 | ns |
| Setup Time for STOP Condition | tsu_STOP |  | 160 |  | ns |
| Bus Capacitance | $\mathrm{C}_{\mathrm{B}}$ |  |  | 100 | pF |
| Pulse Width of Suppressed Spikes | ${ }^{\text {t }}$ SP |  | 0 | 10 | ns |

## Electrical Characteristics (continued)

## $I^{2} \mathrm{C}$ Electrical Characteristics (continued)

$\left(\mathrm{V}_{\mathrm{SYS}}=\mathrm{V}_{\mathrm{INx}}=+3.8 \mathrm{~V}, \mathrm{~V}_{\mathrm{VIO}}=+1.8 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=\mathrm{T}_{\mathrm{J}}=-40^{\circ} \mathrm{C}\right.$ to $+125^{\circ} \mathrm{C}$, typical values are at $\left.\mathrm{T}_{\mathrm{A}}=\mathrm{T}_{\mathrm{J}}=+25^{\circ} \mathrm{C}\right)$

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP MAX | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: |
| ${ }^{2}{ }^{2} \mathrm{C}-\mathrm{COMPATIBLE}$ INTERFACE TIMING (HIGH-SPEED MODE, $\mathrm{C}_{\mathrm{B}}=400 \mathrm{pF}$ ) (Note 5) |  |  |  |  |  |
| Clock Frequency | $\mathrm{f}_{\text {SCL }}$ |  |  | 1.7 | MHz |
| Hold Time (REPEATED) START Condition | $\mathrm{t}_{\text {HD_S }}$ StART |  | 160 |  | ns |
| SCL Low Period | tow |  | 320 |  | ns |
| SCL High Period | $\mathrm{t}_{\mathrm{HIGH}}$ |  | 120 |  | ns |
| Setup Time REPEATED START Condition | tsu_Start |  | 160 |  | ns |
| DATA Hold Time | thD_DATA |  | 0 | 150 | ns |
| DATA Setup Time | tsu_DATA |  | 10 |  | ns |
| SCL Rise Time | $t_{\text {R_SCL }}$ | $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ | 20 | 80 | ns |
| SCL Rise Time after REPEATED START Condition and after Acknowledge Bit | $t_{\text {R_SCL1 }}$ | $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ | 20 | 80 | ns |
| SCL Fall Time | $t_{\text {F_SCL }}$ | $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ | 20 | 80 | ns |
| SDA Rise Time | $t_{\text {R_SDA }}$ | $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ | 20 | 80 | ns |
| SDA Fall Time | $\mathrm{t}_{\text {F_SDA }}$ | $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ |  | 80 | ns |
| Setup Time for STOP Condition | tSU_STOP |  | 160 |  | ns |
| Bus Capacitance | $\mathrm{C}_{\mathrm{B}}$ |  |  | 400 | pF |
| Pulse Width of Suppressed Spikes | tsp |  | 0 | 10 | ns |

## Electrical Characteristics (continued)

## SPI Electrical Characteristics

$\left(\mathrm{V}_{\mathrm{SYS}}=\mathrm{V}_{\text {INx }}=+3.8 \mathrm{~V}, \mathrm{~V}_{\mathrm{VIO}}=+1.8 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=\mathrm{T}_{\mathrm{J}}=-40^{\circ} \mathrm{C}\right.$ to $+125^{\circ} \mathrm{C}$, typical values are at $\left.\mathrm{T}_{\mathrm{A}}=\mathrm{T}_{\mathrm{J}}=+25^{\circ} \mathrm{C}\right)$

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| POWER SUPPLY AND I/O STAGES |  |  |  |  |  |  |
| VIO Supply Voltage Range | $\mathrm{V}_{\mathrm{VIO}}$ |  | 1.65 | 1.8 | $\mathrm{V}_{\text {SYS }}$ | V |
| Input Leakage Current (SCS, SCL, MOSI) | $\begin{aligned} & \mathrm{I}_{\mathrm{IH} \_\mathrm{SPI}}, \\ & \mathrm{I}_{\mathrm{IL} \text { _SPI }} \end{aligned}$ | $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ | -1 | +0.001 | +1 | $\mu \mathrm{A}$ |
|  |  | $\mathrm{T}_{\mathrm{A}}=+85^{\circ} \mathrm{C}$ (Note 4) |  | 0.1 |  |  |
| Input Capacitance (SCS, SCL, MOSI) | $\mathrm{Cl}_{1}$ |  |  | 10 |  | pF |
| Input LOW Voltage (SCS, SCL, MOSI) | VIL |  |  |  | $\begin{aligned} & 0.3 \mathrm{x} \\ & \mathrm{~V}_{\mathrm{VIO}} \end{aligned}$ | V |
| Input HIGH Voltage (SCS, SCL, MOSI) | $\mathrm{V}_{\mathrm{IH}}$ |  | $0.7 x$ <br> $\mathrm{V}_{\mathrm{VIO}}$ |  |  | V |
| Input Hysteresis (SCS, SCL, MOSI) | $\mathrm{V}_{\text {HYS }}$ |  |  | $\begin{aligned} & \hline 0.1 \mathrm{x} \\ & \mathrm{~V}_{\mathrm{VIO}} \end{aligned}$ |  |  |
| MISO Output Low Voltage | $\mathrm{V}_{\mathrm{OL}}$ | $\mathrm{I}_{\mathrm{OL}}=1 \mathrm{~mA}$ |  |  | 0.2 | V |
| MISO Output High Voltage | $\mathrm{V}_{\mathrm{OH}}$ | $\mathrm{I}_{\mathrm{OH}}=1 \mathrm{~mA}$ | $\begin{gathered} \mathrm{V}_{\mathrm{VIO}}- \\ 0.2 \end{gathered}$ |  |  | V |
| MISO Leakage Current | ILK_HIZ | High-impedance state, $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ | -1 | +0.001 | +1 | $\mu \mathrm{A}$ |
|  |  | High-impedance state, $\mathrm{T}_{\mathrm{A}}=+85^{\circ} \mathrm{C}$ (Note 4) |  | 0.1 |  |  |
| SPI INTERFACE TIMING (Note 5) |  |  |  |  |  |  |
| SPI Operating Frequency | $\mathrm{f}_{\text {SCL }}$ |  |  | 26 | 30 | MHz |
| MOSI Input Valid to SCL Rising Edge | tsu_MOSI |  | 10 |  |  | ns |
| MOSI Input Valid from SCL Rising Edge | thD_MOSI |  | 10 |  |  | ns |
| MISO Valid from SCL Rising Edge | $t_{\text {D_M }}$ MISO | $\mathrm{C}_{\mathrm{L}}=50 \mathrm{pF}$ |  | 9 |  | ns |
| MISO Rising/Falling Time | $t_{R}, t_{F}$ | $C_{L}=20 p F$ |  |  | 10 | ns |
| SCS Setup Time | tSU_SCS |  | 20 |  |  | ns |
| SCS Hold Time | tHD_SCS |  | 20 |  |  | ns |
| Minimum SCS High Pulse Width | $t_{\text {SCS_H }}$ H(MIN) |  | 50 |  |  | ns |

Note 3: Limits are $100 \%$ production tested at $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$. Limits over the operating temperature range are guaranteed through correlation using statistical quality control methods.
Note 4: Guaranteed by ATE characterization. Not directly tested in production.
Note 5: Guaranteed by design. Not production tested.
Note 6: Guaranteed by design. Production tested through scan.
Note 7: Internal design target.

## Typical Operating Characteristics

$\left(\mathrm{V}_{\text {SYS }}=3.8 \mathrm{~V}, \mathrm{~V}_{\text {OUT }}=0.85 \mathrm{~V}\right.$, I IOUT $=0 \mathrm{~A}, \mathrm{CE}=$ high, 4-Phase (1 Output), $\mathrm{FPWM}=0, \mathrm{LPM}=0, \mathrm{ETR}=0, \mathrm{~L}=220 \mathrm{nH}, \mathrm{C}_{\text {OUT }}=(22 \mu \mathrm{~F}+$ $0.1 \mu \mathrm{~F}+2 \times 4.3 \mu \mathrm{~F}), \mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$, unless otherwise noted.)


## Typical Operating Characteristics (continued)

$\left(\mathrm{V}_{\text {SYS }}=3.8 \mathrm{~V}, \mathrm{~V}_{\text {OUT }}=0.85 \mathrm{~V}\right.$, I OUT $=0 \mathrm{~A}, \mathrm{CE}=$ high, 4-Phase (1 Output), $\mathrm{FPWM}=0, \mathrm{LPM}=0, \mathrm{ETR}=0, \mathrm{~L}=220 \mathrm{nH}, \mathrm{C}_{\text {OUT }}=(22 \mu \mathrm{~F}+$ $0.1 \mu \mathrm{~F}+2 \times 4.3 \mu \mathrm{~F}), \mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$, unless otherwise noted.)


## Typical Operating Characteristics (continued)

$\left(\mathrm{V}_{\text {SYS }}=3.8 \mathrm{~V}, \mathrm{~V}_{\text {OUT }}=0.85 \mathrm{~V}\right.$, $\mathrm{I}_{\text {OUT }}=0 \mathrm{~A}, \mathrm{CE}=$ high, 4 -Phase ( 1 Output $), \mathrm{FPWM}=0, \mathrm{LPM}=0, \mathrm{ETR}=0, \mathrm{~L}=220 \mathrm{nH}, \mathrm{C}_{\mathrm{OUT}}=(22 \mu \mathrm{~F}+$ $0.1 \mu \mathrm{~F}+2 \times 4.3 \mu \mathrm{~F}), \mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$, unless otherwise noted.)


## Typical Operating Characteristics (continued)

$\left(\mathrm{V}_{\text {SYS }}=3.8 \mathrm{~V}, \mathrm{~V}_{\text {OUT }}=0.85 \mathrm{~V}\right.$, I OUT $=0 \mathrm{~A}, \mathrm{CE}=$ high, 4-Phase (1 Output), $\mathrm{FPWM}=0, \mathrm{LPM}=0, \mathrm{ETR}=0, \mathrm{~L}=220 \mathrm{nH}, \mathrm{C}_{\text {OUT }}=(22 \mu \mathrm{~F}+$ $0.1 \mu \mathrm{~F}+2 \times 4.3 \mu \mathrm{~F}), \mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$, unless otherwise noted.)





## Typical Operating Characteristics (continued)

$\left(\mathrm{V}_{\text {SYS }}=3.8 \mathrm{~V}, \mathrm{~V}_{\text {OUT }}=0.85 \mathrm{~V}\right.$, I OUT $=0 \mathrm{~A}, \mathrm{CE}=$ high, 4-Phase (1 Output), $\mathrm{FPWM}=0, \mathrm{LPM}=0, \mathrm{ETR}=0, \mathrm{~L}=220 \mathrm{nH}, \mathrm{C}_{\text {OUT }}=(22 \mu \mathrm{~F}+$ $0.1 \mu \mathrm{~F}+2 \times 4.3 \mu \mathrm{~F}), \mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$, unless otherwise noted.)





## Typical Operating Characteristics (continued)

$\left(\mathrm{V}_{\text {SYS }}=3.8 \mathrm{~V}, \mathrm{~V}_{\text {OUT }}=0.85 \mathrm{~V}\right.$, I OUT $=0 \mathrm{~A}, \mathrm{CE}=$ high, 4-Phase (1 Output), $\mathrm{FPWM}=0, \mathrm{LPM}=0, \mathrm{ETR}=0, \mathrm{~L}=220 \mathrm{nH}, \mathrm{C}_{\text {OUT }}=(22 \mu \mathrm{~F}+$ $0.1 \mu \mathrm{~F}+2 \times 4.3 \mu \mathrm{~F}), \mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$, unless otherwise noted.)


## Typical Operating Characteristics (continued)

$\left(\mathrm{V}_{\text {SYS }}=3.8 \mathrm{~V}, \mathrm{~V}_{\text {OUT }}=0.85 \mathrm{~V}\right.$, I OUT $=0 \mathrm{~A}, \mathrm{CE}=$ high, 4-Phase (1 Output), $\mathrm{FPWM}=0, \mathrm{LPM}=0, \mathrm{ETR}=0, \mathrm{~L}=220 \mathrm{nH}, \mathrm{C}_{\text {OUT }}=(22 \mu \mathrm{~F}+$ $0.1 \mu \mathrm{~F}+2 \times 4.3 \mu \mathrm{~F}), \mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$, unless otherwise noted.)


## Typical Operating Characteristics (continued)

$\left(\mathrm{V}_{\text {SYS }}=3.8 \mathrm{~V}, \mathrm{~V}_{\text {OUT }}=0.85 \mathrm{~V}, \mathrm{I}_{\text {OUT }}=0 \mathrm{~A}, \mathrm{CE}=\right.$ high, $4-\mathrm{Phase}(1$ Output $), \mathrm{FPWM}=0, \mathrm{LPM}=0, \mathrm{ETR}=0, \mathrm{~L}=220 \mathrm{nH}, \mathrm{C}_{\mathrm{OUT}}=(22 \mu \mathrm{~F}+$ $0.1 \mu \mathrm{~F}+2 \times 4.3 \mu \mathrm{~F}), \mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$, unless otherwise noted.)


## Typical Operating Characteristics (continued)

$\left(\mathrm{V}_{\text {SYS }}=3.8 \mathrm{~V}, \mathrm{~V}_{\text {OUT }}=0.85 \mathrm{~V}, \mathrm{I}_{\text {OUT }}=0 \mathrm{~A}, \mathrm{CE}=\right.$ high, $4-\mathrm{Phase}(1$ Output $), \mathrm{FPWM}=0, \mathrm{LPM}=0, \mathrm{ETR}=0, \mathrm{~L}=220 \mathrm{nH}, \mathrm{C}_{\mathrm{OUT}}=(22 \mu \mathrm{~F}+$ $0.1 \mu \mathrm{~F}+2 \times 4.3 \mu \mathrm{~F}), \mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$, unless otherwise noted.)


## Bump Configuration



## Bump Description

| BUMP | NAME | FUNCTION |
| :---: | :---: | :---: |
| A1, B1, B2 | PGND1 | Phase1 Power Ground |
| A2, A3, B3 | LX1 | Phase1 Switch Node |
| A4, A5, B4, B5 | IN12 | Phase1/2 Input. Bypass to PGND1/2 with a $10 \mu \mathrm{~F}$ capacitor. |
| A6, A7, B6 | LX2 | Phase2 Switch Node |
| A8, B7, B8 | PGND2 | Phase2 Power Ground |
| $\begin{gathered} \text { C1, C8, E5, E8, } \\ \text { F1, F8 } \end{gathered}$ | AGND | Analog Ground |
| C2 | SNS1N | Phase1 Differential Negative Remote Sense Input |
| C3 | $\overline{\mathrm{IRQ}}$ | Interrupt Output. A $100 \mathrm{k} \Omega$ external pullup resistor to VIO is required. High impedance when $C E=$ low. |
| C4 | SNS1P | Phase 1 Differential Positive Remote Sense Input |
| C5 | SNS2P | Phase 2 Differential Positive Remote Sense Input |
| C6 | EN | Global Enable Input (Active-High, Logically ORed with GLB_EN Function of GPIs). An 800k $\Omega$ internal pulldown resistance to DGND. If this pin is not used, leave it unconnected. |
| C7 | SNS2N | Phase 2 Differential Negative Remote Sense Input |
| D1 | SCL | ${ }^{2}{ }^{2} \mathrm{C}$ Clock Input. High impedance in off state. A $1.5 \mathrm{k} \Omega \sim 2.2 \mathrm{k} \Omega$ of pullup resistor to VIO is required. |
| D2 | SCS | Active-Low SPI Chip Select |
| D3 | VIO | IO Supply Voltage Input. Bypass to DGND with a $0.1 \mu \mathrm{~F}$ capacitor. |
| D4 | CE | Active-High Chip Enable Input. <br> $C E=$ High (standby), $\mathrm{I}^{2} \mathrm{C}$ interface is enabled and regulators are ready to be turned on. $C E=$ Low (shutdown), all regulators are turned off and all Type-O registers are reset to their POR default values. |
| D5 | WDTRSTB_IN | Active-Low Watchdog Timer Reset Input. An 800k $\Omega$ internal pullup resistance to VIO. If this pin is not used, leave it unconnected. |
| D6 | LPM | Global Low Power Mode Input (Active-High, Logically ORed with GLB_LPM Function of GPIs). An $800 \mathrm{k} \Omega$ internal pulldown resistance to DGND. If this pin is not used, leave it unconnected. |
| D7 | I2C_SPI_SEL | Serial Interface Selection Input. Latches at $\mathrm{V}_{\text {SYS }}$ POR. I2C_SPI_SEL = Low: ${ }^{2}{ }^{2} \mathrm{C}$ <br> I2C_SPI_SEL = High (VSYS): SPI |
| D8 | SYS | System (Battery) Voltage Input. Bypass to AGND with a $1 \mu \mathrm{~F}$ capacitor. |
| E1 | SDA/MOSI | ${ }^{2}{ }^{2} \mathrm{C}$ Data I/O. High Impedance in Off State. A $1.5 \mathrm{k} \Omega \sim 2.2 \mathrm{k} \Omega$ of pullup resistor to VIO is required. Configured as MOSI when SPI mode is selected. |
| E2 | MISO | SPI Data Output. High impedance in off state. |
| E3 | GPIO | Active-High, General-Purpose Input. An $800 \mathrm{k} \Omega$ internal pulldown resistance to DGND. If this pin is not used, leave it unconnected. |
| E4 | DGND | Digital Ground |

## Bump Description (continued)

| BUMP | NAME | FUNCTION |
| :---: | :---: | :---: |
| E6 | PH_CFG0 | Phase Configuration Selection Input. Latches at $\mathrm{V}_{\text {SYS }}$ POR. <br> PH_CFG2 = low, PH_CFG1 = low, PH_CFG0 = low: 4 phase <br> PH_CFG2 = low, PH_CFG1 = low, PH_CFG0 = high ( $\mathrm{V}_{\mathrm{SYS}}$ ): $3+1$ phase <br> PH_CFG2 = low, PH_CFG1 = high (VSYS), PH_CFG0 = low: $2+2$ phase <br> PH_CFG2 = low, PH_CFG1 = high $\left(\mathrm{V}_{\mathrm{SYS}}\right)$, PH_CFG0 $=$ high $\left(\mathrm{V}_{\mathrm{SYS}}\right): 2+1+1$ phase <br> PH_CFG2 $=$ high $\left(V_{S Y S}\right)$, PH_CFG1 $=X$, PH_CFG0 $=X: 1+1+1+1$ phase |
| E7 | PH_CFG2 | Phase Configuration Selection Input. Latches at $\mathrm{V}_{\text {SYS }}$ POR. <br> PH_CFG2 = low, PH_CFG1 = low, PH_CFG0 = low: 4 phase <br> PH_CFG2 = low, PH_CFG1 = low, PH_CFG0 $=$ high $\left(\mathrm{V}_{\mathrm{SYS}}\right): 3+1$ phase <br> PH_CFG2 = low, PH_CFG1 = high ( $\mathrm{V}_{\text {SYS }}$ ), PH_CFG0 = low: $2+2$ phase <br> PH_CFG2 $=$ low $P H$ CFFG1 $=$ high $\left(V_{S Y S}\right)$, PH_CFG0 $=$ high $\left(V_{S Y S}\right): 2+1+1$ phase <br> PH_CFG2 $=$ high $\left(V_{S Y S}\right)$, PH_CFG1 $=X$, PH_CFG0 $=X: 1+1+1+1$ phase |
| F2 | SNS4N | Phase 4 Differential Negative Remote Sense Input |
| F3 | GPI1 | Active-High, General-Purpose Input. An $800 \mathrm{k} \Omega$ internal pulldown resistance to DGND. If this pin is not used, leave it unconnected. |
| F4 | SNS4P | Phase 4 Differential Positive Remote Sense Input |
| F5 | SNS3P | Phase 3 Differential Positive Remote Sense Input |
| F6 | PH_CFG1 | Phase Configuration Selection Input. Latches at $\mathrm{V}_{\text {SYS }}$ POR. <br> PH_CFG2 = low, PH_CFG1 = low, PH_CFG0 = low: 4 phase <br> PH_CFG2 = low, PH_CFG1 = low, PH_CFG0 = high ( $\mathrm{V}_{\mathrm{SYS}}$ ): $3+1$ phase <br> PH_CFG2 = low, PH_CFG1 = high (VSYS), PH_CFG0 = low: $2+2$ phase <br> PH_CFG2 = low, PH_CFG1 = high ( $\mathrm{V}_{\mathrm{SYS}}$ ), PH_CFG0 = high ( $\mathrm{V}_{\mathrm{SYS}}$ ): $2+1+1$ phase <br> PH_CFG2 $=$ high $\left(V_{S Y S}\right)$, PH_CFG1 $=\mathrm{X}, \mathrm{PH}$ _CFG0 $=\mathrm{X}: 1+1+1+1$ phase |
| F7 | SNS3N | Phase 3 Differential Negative Remote Sense Input |
| G1, G2, H1 | PGND4 | Phase 4 Power Ground |
| G3, H2, H3 | LX4 | Phase 4 Switch Node |
| G4, G5, H4, H5 | IN34 | Phase 3/4 Input. Bypass to PGND3/4 with a $10 \mu \mathrm{~F}$ capacitor. |
| G6, H6, H7 | LX3 | Phase 3 Switch Node |
| G7, G8, H8 | PGND3 | Phase 3 Power Ground |

## 20A User-Configurable Quad-Phase Buck Converter

## Detailed Description

## Top-Level System Management

## System Faults

The MAX77812 monitors the system for the following faults:

- Undervoltage lockout
- VIO fault


## Undervoltage Lockout

When the $\mathrm{V}_{\text {SYS }}$ voltage falls below $\mathrm{V}_{\text {UVLO_F }}$ (2.15V typ), the MAX77812 enters into a shutdown stāte and UVLO forces the MAX77812 to a dormant state until $\mathrm{V}_{\text {SYS }}$ voltage rises above the UVLO rising threshold (typically 2.5 V ). Once the $\mathrm{V}_{\text {SYS }}$ voltage is higher than the UVLO rising threshold, the MAX77812 comes out of shutdown mode to be securely functional. The UVLO falling threshold is programmable through $I^{2} \mathrm{C}$, but it must be set lower than UVLO rising threshold to avoid unexpected behaviors.
It is recommended to set the UVLO_F[2:0] register bits such that the UVLO falling threshold is at least 1.15 V above the programmed output voltage setting.

## VIO Fault

When the VIO supply falls below $\mathrm{V}_{\text {TH_VIO_OK }}$ (1.0V typ), the MAX77812 immediately goes into a shutdown state and stays in this mode until IO supply rises beyond VTH_VIO_OK threshold.

## Thermal Protection

The MAX77812 has a centralized thermal protection circuit which monitors temperature on the die. If the die temperature exceeds $+165^{\circ} \mathrm{C}$ (TSHDN), the MAX77812 initiates a soft-stop for all the output(s) and all Type-O registers are reset to their POR default values. However, the MAX77812 should be able to communicate with the host processor through the serial interface as long as $\mathrm{V}_{\text {SYS }}$ and $\mathrm{V}_{\text {VIO }}$ supplies are within the operating range.
In case the die temperature drops by $15^{\circ} \mathrm{C}$ after the thermal protection occurs, the MAX77812 recovers to the normal state and the output(s) can be turned on again.
In addition to $+165^{\circ} \mathrm{C}$ threshold, there are two additional comparators which trip at $+120^{\circ} \mathrm{C}$ and $+140^{\circ} \mathrm{C}$. Interrupts are generated in the event the die temperature reaches $+120^{\circ} \mathrm{C}$ or $+140^{\circ} \mathrm{C}$.

## Reset Conditions

## Power-On Reset (POR)

When a valid system supply voltage is applied to the device, the MAX77812 goes into shutdown mode and stay there until CE goes high. As the $\mathrm{V}_{\text {SYS }}$ voltage rises above POR threshold ( $\approx 1.60 \mathrm{~V}$ ), the internal reference and the integrated supply are enabled and the MAX77812 starts loading the default register values from the OTPs.

## System Reset

When $V_{\text {SYS }}$ voltage drops below its POR threshold ( $\approx 1.50 \mathrm{~V}$ ), all Type-S1 registers are reset to their POR default values.

## Off Reset

Off reset occurs by any power-off or shutdown events. This condition resets all Type-O registers to their POR default values.

## Software Reset

All Type-O registers can be reset by writing '1' to SW_ RST bit in REG_RESET register. This bit clears to ' $\overline{0}$ ' upon reset.

## Watchdog Timeout Reset (WDTRSTB_IN)

In case the host processor fails to reset its watchdog timer for any system issues, WDTRSTB_IN signal goes low for about 100ms. When the MAX77812 detects that WDTRSTB_IN is low longer than its debounce timer (programmable by WDT_DEB[2:0]), the output voltage setting registers of all phases (Mx_VOUT[7:0]) reset to their POR default values and the output voltages return to their POR default values with given ramp-up/down slew rates.

## Chip Enable (CE)

When $\mathrm{V}_{\text {SYS }}$ and $\mathrm{V}_{\text {VIO }}$ supplies are valid, a logic-high on CE pin puts the MAX77812 into standby mode (enabled). In standby mode, all user registers are accessible through ${ }^{2} \mathrm{C} /$ SPI so that the host processor can overwrite the default output voltages of regulators and each regulator can be enabled by either ${ }^{2} \mathrm{C} / \mathrm{SPI}$ or GPI input if applicable.
When CE pin goes high, the MAX77812 turns on the internal bias circuitry which takes typically $50 \mu$ s to be settled. As soon as the bias is ready, all the regulators are allowed to be turned on via $I^{2} \mathrm{C} / \mathrm{SPI}$ or EN pins. In case the regulators are enabled before the bias circuitry is ready, the regulators require longer time to startup.
When the CE pin is pulled low, the MAX77812 goes into shutdown mode (disabled) and turns off all the regulators regardless of EN pins. This event also resets all Type-O registers to their POR default values.

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## Enable Control

Each master phase of the MAX77812 can be enabled and disabled by a corresponding enable register bit (EN_Mx), EN input and multifunction GPIs. The enable logic is an 'OR' logic of active enable logic signals. For example, the Master1 is enabled when EN_M1 bit, GLB_EN or M1_EN logic signal is set to ' 1 '. When all active signals are ' 0 ', the corresponding master phase is turned off.

## Startup and Shutdown Sequence

The MAX77812 supports programmable startup and shutdown delay times between the master phases. The startup and shutdown sequence is initiated by either EN pin or GLB_EN function of GPIs. The startup and shutdown delay times between the master phases are programmable from 0 ms to 62 ms ( 32 steps).
The startup sequence is set by OTP bits as well as STUP_DLYx registers and the Master 1 is always turned on as soon as a startup sequence is initiated, while the shutdown sequence is programmable by SHDN_DLYx registers only and the delay times for all master phases are programmable.
If any master phase(s) is(are) turned on by EN_Mx bit or Mx_EN input before initiating startup or shutdown, global startup or shutdown sequence does not affect the master phase(s) already turned on or off.
Figure 1 shows a typical startup and shutdown sequence.
For more detailed information on programming the sequencer, refer to Application Note 6826: How to Program Startup and Shutdown Sequence with MAX77812.

## Immediate Shutdown Events

The following events initiate an immediate shutdown:

- $V_{S Y S}<$ SYS UVLO falling threshold (VUVLO_F)
- $\mathrm{V}_{\mathrm{VIO}}<\mathrm{VIO}$ OK threshold ( $\mathrm{V}_{\mathrm{TH}}$ _VIO_OK)

The events in this category are associated with potentially hazardous system states. Powering down the host processor and resetting all Type-O registers help mitigate any issues that can occur due to these potentially hazardous conditions.

## Interrupt and Mask

The $\overline{\mathrm{RQ}}$ output is used to indicate to the host processor that the status on the MAX77812 has changed. The $\overline{\mathrm{IRQ}}$ output asserts (goes low) anytime an unmasked interrupt bit is triggered. The host processor reads the interrupt source register (ADDR 0x01) and the interrupt registers that are indicated by the interrupt source register to see the cause of interrupt event. Note that the interrupt source register is cleared when the corresponding interrupt register group is read by the host processor.
All the interrupt events are edge-triggered. Therefore, the same interrupt is not generated repeatedly even though the interrupt condition persists.

Each interrupt register can be read at a time and all interrupt bits are clear-on-read bits. The $\overline{\mathrm{IRQ}}$ output de-asserts (goes high) when all interrupt bits have been cleared. If an interrupt is captured during the read sequence, $\overline{\mathrm{IRQ}}$ output is held low. When $\overline{\mathrm{IRQ}}$ output is pulled low by an unmasked interrupt event, $\overline{\mathrm{RQ}}$ output stays low until the interrupt bit is cleared by the reading operation of the host processor or the corresponding interrupt mask bit is set to '1' (masked).


Figure 1. Startup and Shutdown Sequence

## 20A User-Configurable Quad-Phase Buck Converter

Each interrupt can be masked (disabled) by setting the corresponding interrupt mask register bit.
When the corresponding mask bit is set (masked), an interrupt bit is not set for an interrupt event. As a result, the $\overline{\mathrm{RQ}}$ output stays high. When the mask bit is cleared, an active interrupt event at the time of clearing the mask bit is captured, which results in pulling the $\overline{\mathrm{RQ}}$ output low.
Interrupt mask bits are set to ' 1 ' by default and are reset to the default values at power-off events.

## Status

In addition to interrupt bits, the MAX77812 has read-only STATUS bits. Those bits always represent the current status of the device. It is highly recommended that the host processor read STATUS bits whenever the MAX77812 is initialized by the host processor. These STATUS bits do not directly affect the state of interrupt bits.

## Quad-Phase Buck Regulator

The MAX77812 uses Maxim's proprietary Quick-PWM ${ }^{\text {TM }}$ adaptive on-time control scheme. Adaptive on-time control provides fast response to load transients, inherent compensation to input voltage variation, and stable performance at low duty cycles. On-times (high-side MOSFET on) are controlled by the on-time generator circuit. This circuit calculates an on-time based on the input voltage $\left(\mathrm{V}_{\mathrm{INx}}\right)$, the output voltage $\left(\mathrm{V}_{\text {OUTX }}\right)$, and the target switching frequency (Fsw). The on-time is modified (slightly shortened or lengthened) by the phase current balancing control circuit. Off-times (low-side MOSFET on) begin when the on-time ends. Shoot-through current from $\operatorname{INx}$ to PGNDx is avoided by introducing a brief period of deadtime between switching events when neither MOSFET is on. During the dead-time, the inductor current conducts through the intrinsic body diode of the low-side MOSFET.

The PWM comparator regulates VOUTx by modulating off-time. A compensation ramp is fed to the positive input of the PWM comparator and the negative input is a voltage proportional to the actual output voltage error added to the replicated AC current in the inductor. The PWM comparator begins an on-time (and resets the compensation ramp) when the error voltage plus replicated AC inductor current becomes greater than the ramp. When the calculated on-time expires, the off-time automatically begins. One PWM comparator is used to control all phases in multiphase configuration. The output is demultiplexed by a phase scheduler which controls the phase spacing of each switching stage (e.g., $2 \Phi$ is spaced $180^{\circ}$ apart, $3 \Phi$ is spaced $120^{\circ}, 4 \Phi$ is spaced $90^{\circ}$ ). Multiphase configurations permanently have all phases activated and always switches in sequence during steady-state operation (phases do not add or shed).
The switching frequency (FSW) of the adaptive on-time BUCK is variable and heavily influenced by the instantaneous load. More on-time pulses in a given time (higher $\mathrm{F}_{\text {SW }}$ ) is observed as load increases. Fewer on-times in a given time (lower FSW) is observed as load decreases.

## Phase/Output Configurations

The MAX77812 supports user-programmable phase configuration by PH_CFG0, PH_CFG1 and PH_CFG2 input logic state. The input logic state is latched at the POR event.

All supported phase configurations are shown in Table 1. Refer to Application Note 6804: Guidelines for the MAX77812 User-Selectable Phase Configurations and How to Select Them for a concise summary of all the information regarding phase configurations found in this data sheet.

Table 1. User-Programmable Phase/Output Configurations

| PH_CFG2 | PH_CFG1 | PH_CFG0 | PHASE CONFIGURATION |
| :---: | :---: | :---: | :--- |
| Low | Low | Low | 1 Output: 4-Phase (Master 1) |
| Low | Low | High | 2 Outputs: 3-phase (Master 1) + 1-phase (Master 4) |
| Low | High | Low | 2 Outputs: 2-phase (Master 1) + 2-phase (Master 3) |
| Low | High | High | 3 Outputs: 2-phase (Master 1) + 1-phase (Master 3) + 1-phase (Master 4) |
| High | $X$ | $X$ | 4 Outputs: 1-phase (Master 1) + 1-phase (Master 2) + 1-phase (Master 3) + <br> 1-phase (Master 4) |

## 20A User-Configurable Quad-Phase Buck Converter

Based on the selected phase configuration, the phase selector generates the TON signals to each power stage with different phase interleaving schemes and the master phases are assigned as shown in Figure 2.
Note that only registers for the master phase(s) are activated and the slave phase(s) are controlled by the corresponding master phase(s).

## SKIP/Forced PWM Operation

In normal operating mode, buck automatically transitions from skip mode to fixed frequency operation as the load current increases. For operating modes where lowest output ripple is required, Forced PWM switching behavior can be enabled by writing ' 1 ' to Mx_FPWM bit.

## Low Power Mode

Each master includes LPM (low power mode) operation to minimize the quiescent current when the host processor is in sleep state. In LPM, the ETR (enhanced transient response), ADT (adaptive dead-time control), and $\overline{\text { POK }}$ comparator (POK = high) are disabled so that load transient response of the buck regulators are derated as the trade-off. The LPM of each master can be enabled independently by Mx_LPM bits.

## Startup and Soft-Start

When starting up buck regulator, the bias circuitry must be enabled and provided with adequate time to settle. The bias circuitry is guaranteed to settle within $250 \mu \mathrm{~s}$, at which time, the buck regulators power-up sequence can commence. Note that attempting to implement a power-up sequence before the BIASOK signal is generated results in all enabled regulators starting up at the same time.
The buck regulator supports starting into a prebiased output. For example, if the output capacitor has an initial voltage of 0.4 V when the regulator is enabled, the regulator
gracefully increases the capacitor voltage to the required target voltage such as 1.0 V . This is unlike other regulators without the start into prebias feature where they can force the output capacitor voltage to OV before the soft-start ramp begins.
The buck regulator supports programmable soft-start rate from $1.25 \mathrm{mV} / \mu \mathrm{s}$ to $60 \mathrm{mV} / \mu \mathrm{s}$. The controlled soft-start rate and buck regulator current limit (ILIM_PEAK) limit the input inrush current to the output capacitor (IINRUSH). IINRUSH $=\min$ (ILIM_PEAK \& COUT $x \mathrm{dv} / \mathrm{dt}$ ). Note that the input current of the buck regulator is lower than the inrush current to the output capacitor by the ratio of output to input voltage.

## Output Voltage Setting

The output voltage is programmable from 0.25 V to 1.525 V in 5 mV steps to allow fine adjustment to the processor supply voltage under light load conditions to minimize power loss within the processor. Each master phase have three output voltage control registers. Mx_VOUT[7:0] register is for normal operation and Mx_VOUT_D[7:0] and Mx VOUT_S[7:0] are used for voltage selection function by GPIx. See the *Multifunction GPIs* section. The default output voltages are set by an OTP option at the factory. The default output voltages can be overwritten by changing the contents in Mx_VOUT[7:0] register prior to enabling the regulator. It is recommended to maintain at least 1.15 V of headroom between $\mathrm{V}_{\mathrm{SYS}}$ and the programmed output voltage setting.
For some applications, an output voltage higher than 1.525 V is required. The MAX77812 supports higher output voltage with the addition of an external voltage-divider network. For more details, refer to Application Note 6823: Generating a Higher Output Voltage than 1.525V Using the MAX77812.


Figure 2. Buck Phase Configuration

## 20A User-Configurable Quad-Phase Buck Converter

## Changing Output Voltage During Operation

In a typical smartphone or tablet application, there are several power domains in which the operating frequency of the processor is increased or decreased (DVFS). When the operating frequency needs to be changed, it is expected that the buck regulator responds to a command to change the output voltages to new target values quickly. The high peak current limit, coupled with low inductance and small output capacitance, allows the buck regulator to respond to a positive step change in output voltage and settle to the new target value quickly. The buck regulator provides programmable ramp-up slew rates to accommodate different requirements.
For a negative step change in output voltage, the settling time is not critical. In Forced PWM mode (either Mx_FPWM bit or Mx_FSREN bit is enabled), the negative inductor current through NMOS discharges energy from the output capacitor, which helps the output voltage to decrease to the new target value faster. In skip mode, the negative inductor current is not allowed so that the output voltage settling time is dependent on the load current and the output capacitance.

## Output Voltage Slew Rate Control

The buck regulator supports programmable slew rate control feature when increasing and decreasing the output voltage. The ramp-up slew rate can be set to $1.25 \mathrm{mV} /$ $\mu \mathrm{s}, 2.5 \mathrm{mV} / \mu \mathrm{s}, 5 \mathrm{mV} / \mu \mathrm{s}, 10 \mathrm{mV} / \mu \mathrm{s}, 20 \mathrm{mV} / \mu \mathrm{s} 40 \mathrm{mV} / \mu \mathrm{s}$ or $60 \mathrm{mV} / \mu \mathrm{s}$ independently via B_RU_SR[2:0] bits, while the ramp-down slew rate is programmable to $1.25 \mathrm{mV} /$ $\mu \mathrm{s}, 2.5 \mathrm{mV} / \mu \mathrm{s}, 5 \mathrm{mV} / \mu \mathrm{s}, 10 \mathrm{mV} / \mu \mathrm{s}, 20 \mathrm{mV} / \mu \mathrm{s} 40 \mathrm{mV} / \mu \mathrm{s}$ or $60 \mathrm{mV} / \mu \mathrm{s}$ through B_RD_SR[2:0].

## Remote Output Voltage Sensing

All phases support differential remote output voltage sensing feature for improving point of load regulation. Differential feedback (SNSxP and SNSxN) enables voltage sensing directly at the point of load, ensuring best voltage regulation at the load, regardless of power plane impedances.

## Output Active Discharge

BUCK provides an internal $100 \Omega$ resistor for output active discharge function. If the active discharge function is enabled ( $M x \_A D=1$ ), the internal resistor discharges the energy stored in the output capacitor to PGNDx whenever the regulator is disabled.
Either the regulator remains enabled or the active discharge function is disabled ( $\mathrm{Mx} \_\mathrm{AD}=0$ ), the internal
resistor is disconnected from the output. If the active discharge function is disabled, the output voltage decays at a rate that is determined by the output capacitance and the load current when the regulator is turned off.

## Enhanced Transient Response

The MAX77812 features the enhanced transient response (ETR) function to improve the output-voltage transient responses with very fast load changes. When enabled, the ETR function monitors the output voltage and detects high dv/dt undershoot and overshoot separately.
When the negative ETR (NETR) is detected during output-voltage undershoot, the buck controllers turn on all master and slave phases assigned to the same output at the same time (in-phase) until the NETR is de-asserted. This allows the multi-phase buck converters (no significant impact on single-phase buck) to pump up energy to the output in order to recover from the undershoot quickly.
When the positive ETR (PETR) is detected, the buck controllers turn off the corresponding low-side MOSFETs to discharge excessive energy stored in the inductors, which results in suppressing output-voltage overshoot. When the PETR is released, the buck controllers operate in FPWM mode for about 5 ms before returning to normal operation.
Both NETR and PETR functions are enabled by default, but they can be turned off to reduce quiescent current by clearing the B_NETR_EN and B_PETR_EN bits in the GLB_CFG3 register.

## Inductor Selection

The buck regulator is optimized for 220 nH to 470 nH inductors. The lower the inductor DCR, the higher the buck efficiency is. Users need to trade off inductor size with DCR value and choose a suitable inductor for the buck.

## Inductor Current Limit

A cycle-by-cycle current limit provides overcurrent protection by monitoring the current in the high-side and lowside MOSFETs. The peak current limit (IPLIM) triggers during on-time and prevents the inductor current from running away. If IPLIM trips, the on-time ends and the low-side MOSFET turns on to reduce the inductor current until it hits the valley current limit (lVLIM). Once the current falls to $\mathrm{I}_{\mathrm{VLIM}}$, normal operation resumes. Note that the buck output current is limited to (IPLIM $\left.+I_{\text {VLIM }}\right) / 2$. For more detailed information, refer to Application Note 6820: How Overcurrent Protections Works in the MAX77812.

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## Input and Output Capacitor Selection

The input capacitor, $\mathrm{C}_{\mathrm{IN}}$, reduces the current peaks drawn from the battery or input power source and reduces switching noise in the device. The impedance of $C_{I N}$ at the switching frequency should be kept very low. Ceramic capacitors with X5R or X7R dielectrics are highly recommended due to their small size, low ESR, and small temperature coefficients. For most applications a $10 \mu \mathrm{~F}$ capacitor is sufficient.
The output capacitor, COUT, is required to keep the output voltage ripple small and to ensure regulation loop stability. COUT must have low impedance at the switching frequency. Ceramic capacitors with X5R or X7R dielectric are highly recommended due to their small size, low ESR, and small temperature coefficients. Due to the unique feedback network, the output capacitance can be very low. The recommended minimum output capacitance per phase is $22 \mu \mathrm{~F}$.

## Unused Outputs

Follow these guidelines when the application has unused buck outputs:

- Connected unused inputs (INx) to SYS.
- Leave unused LXx pins unconnected (open).
- Connect unused SNSxN and PGNDx pins to ground.
- Connect unused SNSxP pins to either input or ground, depending on the state of the unused output in the application:
- If the unused output can be enabled at any point in the application, either by the global enable input pin (EN) or a GPIx set to be a global enable, connect the unused SNSxP to INx.
- If the unused output is disabled by default and will never be enabled, connect the unused SNSxP to ground.
Do not confuse unused outputs with unused phases. Phases configured under a master controller in a multiphase configuration must connect according to Table 1.
If possible, do not enable unused outputs. An unused output with a floating LX pin might try switching the LX node indefinitely (depending on the SNSxP connection), which wastes supply current.


## PCB Trace Resistance

The evaluation kit (and the typical PCB on which the MAX77812 is expected to be designed in) utilize $1 / 3 \mathrm{oz}$. Cu , which is plated up to 0.5 oz . 0.5 oz . Cu has a typical resistance of $1 \mathrm{~m} \Omega$ per square.

## Power-OK ( $\overline{\text { POK }})$

The $\overline{\mathrm{POK}}$ comparator is active whenever the regulator is enabled, soft-start has finished, and the regulator is not in low-power mode. The Mx_ $\overline{\mathrm{POK}}$ bits are ' 0 ' by default and assert to ' 1 ' if the output falls below the output POK trip falling threshold level while the output is enabled.

Table 2. Suggested Inductors

| MFGR. | SERIES | NOMINAL <br> INDUCTANCE <br> $(\mathbf{n H})$ | TYPICAL DC <br> RESISTANCE <br> $(\mathbf{m} \Omega)$ | CURRENT <br> RATING (A) <br> $\mathbf{- 3 0 \% ( \Delta L / L ) ~}$ | CURRENT <br> RATING [A] <br> $\Delta \mathbf{T}=+\mathbf{4 0} \mathbf{C} \mathbf{R I S E}$ | DIMENSIONS <br> $\mathbf{L} \mathbf{x} \mathbf{W} \mathbf{x ~ H}$ <br> $(\mathbf{m m})$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Cyntec | HMLE20161B-R22MDR | 220 | 13 | 5.8 | 5.3 | $2.0 \times 1.6 \times 1.2$ |
| TOKO | DFE201610-E-R24N | 240 | 16 | 7.0 | 5.5 | $2.0 \times 1.6 \times 1.0$ |
| ALPS | GLULMR2201A | 220 | 9 | 6.5 | 7.0 | $2.5 \times 2.0 \times 1.2$ |

Table 3. Suggested Capacitors

| MFGR. | SERIES | NOMINAL <br> CAPACITANCE <br> $(\boldsymbol{\mu F )}$ | RATED <br> VOLTAGE <br> $(\mathbf{V})$ | TEMPERATURE <br> CHARACTERISTICS | CASE SIZE <br> $($ (Imperial) | DIMENSIONS <br> $\mathbf{L} \times \mathbf{W} \mathbf{x} \mathbf{H}$ <br> $(\mathbf{m m})$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Murata | GRM188R60J106ME84 | $10 \pm 20 \%$ | 6.3 | X5R | 0603 | $1.6 \times 0.8 \times 0.8$ |
| Murata | GRM188R60J226MEA0 | $22 \pm 20 \%$ | 6.3 | X5R | 0603 | $1.6 \times 0.8 \times 0.8$ |

Table 4. Multifunction GPI Configurations

| GPIx_FUNC[3:0] | FUNCTION | REMARK |
| :---: | :---: | :--- |
| 0000b | GLB_EN | Global Enable (Master 1 through Master 4) |
| 0001b | M1_EN | Master 1 Enable |
| 0010b | M2_EN | Master 2 Enable |
| 0011b | M3_EN | Master 3 Enable |
| 0100b | M4_EN | Master 4 Enable |
| 0101b | GLB_VSEL | Global Voltage Selection (Master 1 through Master 4) |
| 0110b | M1_VSEL | Master 1 Voltage Selection |
| 0111b | M2_VSEL | Master 2 Voltage Selection |
| 1000b | M3_VSEL | Master 3 Voltage Selection |
| 1001b | M4_VSEL | Master 4 Voltage Selection |
| 1010b | GLB_LPM | Global Low Power Mode Select (Master 1 through Master 4) |
| 1011b | M1_LPM | Master 1 Low Power Mode Enable |
| 1100b | M2_LPM | Master 2 Low Power Mode Enable |
| 1101b | M3_LPM | Master 3 Low Power Mode Enable |
| 1110b | M4_LPM | Master 4 Low Power Mode Enable |
| 1111b | No function | - |

## Multifunction GPIs

## General Description

The MAX77812 has two general purpose inputs (GPIO and GPI1) that can be configured as the enable of regulators, the output voltage selection, the low power mode control and no function. The function of these two inputs is programmable through ${ }^{2}{ }^{2} \mathrm{C} /$ SPI (GPI_FUNC register) on the fly. Application Note 6822: How to Use MultiFunction GPIs? provides an in-depth look at programming the GPIs for their various functions.

## Enable Control by GPI

When the GPIx are configured as output enable pins, the enable logic of a specific regulator is an 'OR' logic of the GPIx and the corresponding enable register bit (Mx_EN). For example, if GPIO_FUNC[3:0] = 0001b, the buck Master 1 enable is controlled by GPIO and M1_EN bit.
In case the two GPIs are configured as the same enable function (i.e., GPIO_FUNC[3:0] = GPI1_FUNC[3:0] = 0010b), those inputs are ORed with M2_EN bit. GLB_EN function (GPIO_FUNC[3:0] = 0000b) allows the host processor to enable all the masters in sequence based on STUP_DLYx registers. Note that M1 thru M4 are defined by PH_CFG0, PH_CFG1 and PH_CFG2 inputs.

## Voltage Selection by GPI

The buck has two additional output voltage control registers (Mx_VOUT_D[7:0] and Mx_VOUT_S[7:0]) besides one (Mx_VOUT[7:0]) for normal operation. Those two additional registers are for storing the default output voltage and the system sleep mode output voltage for a specific host processor.
When GPIx are configured as voltage selection pins, the output voltage of a specific regulator is set by Mx_ VOUT_D[7:0] and Mx_VOUT_S[7:0] registers based on the input logic. For example, if GPIO_FUNC[3:0] = 0101b, the output voltages of all the masters are set by Mx VOUT_D[7:0] and Mx_VOUT_S[7:0] when GPI0 = high and GPIO $=$ low, respectively. In case the two GPIs are configured as the same voltage selection function, those inputs are ORed. During the output voltage transition, the ramp-up/down slew rate is controlled by B_RU_SR[2:0] and B_RD_SR[2:0]. Note that M1 thru M4 are defined by PH_CFGO, PH_CFG1 and PH_CFG2 inputs.

## Low Power Mode by GPI

When GPIx are configured as low power mode enable pins, the low power mode enable logic of a specific regulator is an 'OR' logic of GPIx and the corresponding enable register bit (Mx_LPM). For example, if GPIO_FUNC[3:0] $=1011 \mathrm{~b}$, the buck Master 1 low power mode enable is controlled by GPIO and M1_LPM bit.

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In case the two GPIs are configured as the same enable function (i.e., GPIO_FUNC[3:0] = GPIO_FUNC[3:0] = 1100b), those inputs are ORed with M2_LPM bit. GLB_ LPM function (GPIO_FUNC[3:0] = 1010b) allows the host processor to enable low power mode of all the masters at the same time. Note that M1 thru M4 are defined by PH_CFG0, PH_CFG1, and PH_CFG2 inputs.

## I2C Serial Interface

## General Description

The ${ }^{2}{ }^{2}$ C-compatible 2-wire serial interface is used for regulator on/off control, setting output voltages, and other functions. See the Register Map section for details.
The ${ }^{2}{ }^{2} \mathrm{C}$ serial bus consists of a bidirectional serial-data line (SDA) and a serial clock (SCL). ${ }^{2} \mathrm{C}$ is an open-drain bus. SDA and SCL require pullup resistors ( $500 \Omega$ or greater). Optional $24 \Omega$ resistors in series with SDA and SCL help to protect the device inputs from high voltage spikes on the bus lines. Series resistors also minimize crosstalk and undershoot on bus lines.

## System Configuration

The ${ }^{2}{ }^{2} \mathrm{C}$ bus is a multimaster bus. The maximum number of devices that can attach to the bus is only limited by bus capacitance.
Figure 3 shows an example of a typical $I^{2} \mathrm{C}$ system. A device on ${ }^{2}{ }^{2} \mathrm{C}$ bus that sends data to the bus in called a transmitter. A device that receives data from the bus is called a receiver. The device that initiates a data transfer and generates SCL clock signals to control the data transfer is a master. Any device that is being addressed by the master is considered a slave. When the MAX77812 I²Ccompatible interface is operating, it is a slave on $I^{2} \mathrm{C}$ bus and it can be both a transmitter and a receiver.

## Bit Transfer

One data bit is transferred for each SCL clock cycle. The data on SDA must remain stable during the high portion of SCL clock pulse. Changes in SDA while SCL is high are control signals (START and STOP conditions).


Figure 3. Functional Logic Diagram for Communications Controller


Figure 4. ${ }^{2}{ }^{2}$ C Bit Transfer

## START and STOP Conditions

When I2C serial interface is inactive, SDA and SCL idle high. A master device initiates communication by issuing a START condition. A START condition is a high-to-low transition on SDA with SCL high. A STOP condition is a low-to-high transition on SDA, while SCL is high.
A START condition from the master signals the beginning of a transmission to the MAX77812. The master terminates transmission by issuing a NOT ACKNOWLEDGE followed by a STOP condition.
A STOP condition frees the bus. To issue a series of commands to the slave, the master can issue REPEATED START (Sr) commands instead of a STOP command in order to maintain control of the bus. In general, a REPEATED START command is functionally equivalent to a regular START command.


Figure 5. $I^{2}$ C Start Stop

When a STOP condition or incorrect address is detected, the MAX77812 internally disconnects SCL from ${ }^{2}{ }^{2}$ C serial interface until the next START condition, minimizing digital noise and feedthrough.

## Acknowledge

Both the ${ }^{12} \mathrm{C}$ bus master and the MAX77812 (slave) generate acknowledge bits when receiving data. The acknowledge bit is the last bit of each nine bit data packet. To generate an ACKNOWLEDGE (A), the receiving device must pull SDA low before the rising edge of the acknowledge-related clock pulse (ninth pulse) and keep it low during the high period of the clock pulse. To generate a NOT ACKNOWLEDGE ( $n A$ ), the receiving device allows SDA to be pulled high before the rising edge of the acknowledge-related clock pulse and leaves it high during the high period of the clock pulse.
Monitoring the acknowledge bits allows for detection of unsuccessful data transfers. An unsuccessful data transfer occurs if a receiving device is busy or if a system fault has occurred. In the event of an unsuccessful data transfer, the bus master should reattempt communication at a later time.

## Slave Address

The ${ }^{2}{ }^{2} \mathrm{C}$ slave address is set by buck phase configuration as shown in Table 5. If two MAX77812 devices with the same phase configuration need to be connected to the same I2C bus, contact a Maxim representative.

Table 5. I ${ }^{2}$ C Slave Address

| PH_CFG2 | PH_CFG1 | PH_CFG0 | $\begin{array}{c}\text { SLAVE ADDRESS } \\ \text { (7-BIT) }\end{array}$ | $\begin{array}{c}\text { SLAVE ADDRESS } \\ \text { (WRITE) }\end{array}$ | $\begin{array}{c}\text { SLAVE ADDRESS } \\ \text { (READ) }\end{array}$ |
| :---: | :---: | :---: | :---: | :---: | :---: |
| MAX77812EWB+, MAX77812AEWB+, MAX77812BEWB+, MAX77812CEWB+, MAX77812DEWB+ |  |  |  |  |  |$]$



Figure 6. Slave Address Byte Example

## Clock Stretching

In general, the clock signal generation for $\mathrm{I}^{2} \mathrm{C}$ bus is the responsibility of the master device. ${ }^{2}{ }^{2} \mathrm{C}$ specification allows slow slave devices to alter the clock signal by holding down the clock line. The process in which a slave device holds down the clock line is typically called clock stretching. The MAX77812 does not use any form of clock stretching to hold down the clock line.

## General Call Address

The MAX77812 does not implement the $1^{2} \mathrm{C}$ specification general call address. If the MAX77812 sees general call address (00000000b), it does not issue an ACKNOWLEDGE (A).

## Communication Speed

The MAX77812 provides an I2C 3.0-compatible (3.4MHz) serial interface.

- $I^{2} C$ Revision 3 Compatible Serial Communications Channel
- 0 Hz to 100 kHz (Standard Mode)
- 0 Hz to 400 kHz (Fast Mode)
- 0 Hz to 1 MHz (Fast Mode Plus)
- 0 Hz to 3.4 MHz (High-speed Mode)
- Does not utilize $\mathrm{I}^{2} \mathrm{C}$ Clock Stretching

Operating in standard mode, fast mode and fast mode plus does not require any special protocols. The main consideration when changing the bus speed through this range is the combination of the bus capacitance and pullup resistors. Higher time constants created by the
bus capacitance and pullup resistance ( $C \times R$ ) slow the bus operation. Therefore, when increasing bus speeds the pullup resistance must be decreased to maintain a reasonable time constant. See the Pullup Resistor Sizing section of the ${ }^{2}{ }^{2} \mathrm{C}$ revision 3.0 specification for detailed guidance on the pullup resistor selection. In general, for bus capacitance of 200 pF , a 100 kHz bus needs $5.6 \mathrm{k} \Omega$ pullup resistors, a 400 kHz bus needs about a $1.5 \mathrm{k} \Omega$ pullup resistors, and a 1 MHz bus needs $680 \Omega$ pullup resistors. Note that the pullup resistor is dissipating power when the open-drain bus is low. The lower the value of the pullup resistor, the higher the power dissipation (V2/R).
Operating in high-speed mode requires some special considerations. For the full list of considerations, see the $I^{2} \mathrm{C}$ 3.0 specification. The major considerations with respect to the MAX77812 are:

- I2C bus master use current source pullups to shorten the signal rise times.
- $\quad{ }^{2} \mathrm{C}$ slave must use a different set of input filters on its SDA and SCL lines to accommodate for the higher bus speed.
- The communication protocols need to utilize the high-speed master code.
At power-up and after each STOP condition, the MAX77812 inputs filters are set for standard mode, fast mode, or fast mode plus (i.e., 0 Hz to 1 MHz ). To switch the input filters for high-speed mode, use the high-speed master code protocols that are described in the Protocols section.


## Communication Protocols

The MAX77812 supports both writing and reading from its registers.

## Writing to a Single Register

Figure 7 shows the protocol for $\mathrm{I}^{2} \mathrm{C}$ master device to write one byte of data to the MAX77812. This protocol is the same as SMBus specification's write byte protocol.
The write byte protocol is as follows:

1) The master sends a START command (S).
2) The master sends the 7-bit slave address followed by a write bit ( $R / \bar{W}=0$ ).
3) The addressed slave asserts an ACKNOWLEDGE
(A) by pulling SDA low.
4) The master sends an 8-bit register pointer.
5) The slave acknowledges the register pointer.
6) The master sends a data byte.
7) The slave acknowledges the data byte. At the rising edge of SCL, the data byte is loaded into its target register and the data becomes active.
8) The master sends a STOP condition (P) or a REPEATED START condition (Sr). Issuing a P ensures that the bus input filters are set for 1 MHz or slower operation. Issuing a REPEATED START (Sr) leaves the bus input filters in their current state.


$$
\begin{aligned}
& \text { *P FORCES THE BUS FILTERS TO SWITCH TO THEIR } \leq 1 \mathrm{MHz} \text { MODE. } \\
& \text { Sr LEAVES THE BUS FILTERS IN THEIR CURRENT STATE. }
\end{aligned}
$$



Figure 7. Writing to a Single Register with Write Byte Protocol

## Writing to Sequential Registers

Figure 8 shows the protocol for writing to a sequential registers. This protocol is similar to the write byte protocol, except the master continues to write after it receives the first byte of data. When the master is done writing it issues a STOP or REPEATED START
The writing to sequential registers protocol is as follows:

1) The master sends a START command (S).
2) The master sends the 7-bit slave address followed by a write bit $(R / \bar{W}=0)$.
3) The addressed slave asserts an ACKNOWLEDGE (A) by pulling SDA low.
4) The master sends an 8-bit register pointer.
5) The slave acknowledges the register pointer.
6) The master sends a data byte.
7) The slave acknowledges the data byte. At the rising edge of SCL, the data byte is loaded into its target register and the data becomes active.
8) Steps 6 to 7 are repeated as many times as the master requires.
9) During the last acknowledge related clock pulse, the master issues an ACKNOWLEDGE (A).
10) The master sends a STOP condition (P) or a REPEATED START condition (Sr). Issuing a $P$ ensures that the bus input filters are set for 1 MHz or slower operation. Issuing a REPEATED START (Sr) leaves the bus input filters in their current state.



Figure 8. Writing to Sequential Registers " $X$ " to " $N$ "

## Writing Multiple Bytes using Register-Data Pairs

Figure 9 shows the protocol for $\mathrm{I}^{2} \mathrm{C}$ master device to write multiple bytes to the MAX77812 using register-data pairs. This protocol allows $I^{2} \mathrm{C}$ master device to address the slave only once and then send data to multiple registers in a random order. Registers may be written continuously until the master issues a STOP condition.
The "Multiple Byte Register-Data Pair" protocol is as follows:

1) The master sends a START command.
2) The master sends the 7-bit slave address followed by a write bit.
3) The addressed slave asserts an ACKNOWLEDGE (A) by pulling SDA LOW.
4) The master sends an 8-bit register pointer.
5) The slave acknowledges the register pointer.
6) The master sends a data byte.
7) The slave acknowledges the data byte. At the rising edge of SCL, the data byte is loaded into its target register and the data will become active.
8) Steps 4 to 7 are repeated as many times as the master requires.
9) The master sends a STOP condition.


Figure 9. Writing to Multiple Registers with Multiple Byte Register Data Pairs Protocol

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## Reading from a Single Register

${ }^{2}{ }^{2} \mathrm{C}$ master device reads one byte of data to the MAX77812. This protocol is the same as SMBus specification's read byte protocol.
The read byte protocol is as follows:

1) The master sends a START command (S).
2) The master sends the 7-bit slave address followed by a write bit ( $R / \bar{W}=0$ ).
3) The addressed slave asserts an ACKNOWLEDGE (A) by pulling SDA low.
4) The master sends an 8-bit register pointer.
5) The slave acknowledges the register pointer.
6) The master sends a REPEATED START command ( Sr ).
7) The master sends the 7-bit slave address followed by a read bit ( $\mathrm{R} / \overline{\mathrm{W}}=1$ ).
8) The addressed slave asserts an ACKNOWLEDGE (A) by pulling SDA low.
9) The addressed slave places 8-bits of data on the bus from the location specified by the register pointer.
10) The master issues a NOT ACKNOWLEDGE (nA).
11) The master sends a STOP condition ( P ) or a REPEATED START condition (Sr). Issuing a $P$ ensures that the bus. input filters are set for 1 MHz or slower operation. Issuing a REPEATED START (Sr) leaves the bus input filters in their current state.
Note that every time the MAX77812 receives a STOP, its register pointer is set to $0 \times 00$. If reading register $0 \times 00$ after a STOP has been issued, steps 1 to 6 in the above algorithm can be skipped.

## Reading from Sequential Registers

Figure 10 shows the protocol for reading from sequential registers. This protocol is similar to the read byte protocol except the master issues an ACKNOWLEDGE (A) to sig-
nal the slave that it wants more data. When the master has all the data it requires, it issues a NOT ACKNOWLEDGE ( nA ) and a STOP $(P)$ to end the transmission.
The continuous read from sequential registers protocol is as follows:

1) The master sends a START command (S).
2) The master sends the 7-bit slave address followed by a write bit ( $R / \bar{W}=0$ ).
3) The addressed slave asserts an ACKNOWLEDGE (A) by pulling SDA low.
4) The master sends an 8-bit register pointer.
5) The slave acknowledges the register pointer.
6) The master sends a REPEATED START command (Sr).
7) The master sends the 7-bit slave address followed by a read bit $(R / \bar{W}=1)$.
8) The addressed slave asserts an ACKNOWLEDGE (A) by pulling SDA low.
9) The addressed slave places 8 bits of data on the bus from the location specified by the register pointer.
10) The master issues an ACKNOWLEDGE (A) signaling the slave that it wishes to receive more data.
11) Steps 9 to 10 are repeated as many times as the master requires. Following the last byte of data, the master must issue a NOT ACKNOWLEDGE (nA) to signal that it wishes to stop receiving data.
12) The master sends a STOP condition ( $P$ ) or a REPEATED START condition ( Sr ). Issuing a STOP ( P ) ensures that the bus input filters are set for 1 MHz or slower operation. Issuing a REPEATED START (Sr) leaves the bus input filters in their current state.
Note that every time the MAX77812 receives a STOP its register pointer is set to $0 \times 00$. If reading register $0 x 00$ after a STOP has been issued, steps 1 to 6 in the above algorithm can be skipped.

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## Engaging HS Mode for Operation Up to 3.4 MHz

Figure 11 shows the protocol for engaging HS mode operation. HS mode operation allows for a bus operating speed up to 3.4 MHz .
The engaging HS mode protocol is as follows:

1) Begin the protocol while operating at a bus speed of 1 MHz or lower.
2) The master sends a START command (S).
3) The master sends the 8 -bit master code of 00001 xxxb where xxxb are don't care bits.
4) The addressed slave issues a NOT ACKNOWLEDGE ( nA ).
5) The master can now increase its bus speed up to 3.4 MHz and issue any read/write operation.

The master can continue to issue high-speed read/write operations until a STOP $(P)$ is issued. Issuing a STOP (P) ensures that the bus input filters are set for 1 MHz or slower operation.

The MAX77812 ${ }^{12}$ C supports the HS mode extension feature. The HS extension feature keeps the high-speed operation even after STOP condition. This eliminates the needs of HS master code issued by the $\mathrm{I}^{2} \mathrm{C}$ master controller when the $\mathrm{I}^{2} \mathrm{C}$ master controller wants to stay in HS mode for multiple read/write cycles.
As shown in the state diagram, the HS extension mode can be enabled by setting HS_EXT bit in ${ }^{2}$ C__CFG register (ADDR 0x15) from LS mode only (entering HS extension mode from HS mode is not supported).

## SPI Slave Controller

The serial interface includes a SPI slave controller and the selection between ${ }^{2} \mathrm{C}$ and SPI slave controller is done by ${ }^{2}$ C_SPI_SEL input pin. The SPI slave controller requires a reset every time before the SPI master controller starts a new frame. This can be done by setting SCS (SPI chip select, active low) input high for more than 50 ns . When SCS is held high, the MISO output is in a highimpedance state.


Figure 10. Reading Continuously from Sequential Registers " $X$ " to " $N$ "


Figure 11. Engaging HS Mode

## Features

The SPI slave controller has following features:

- Slave Only
- Single Read/Write Support
- Multiple Read/Write Support
- Up to 30 MHz ( 26 MHz typ)


## General Description

The SPI slave controller works with CKPOL $=0$, CKPHA $=0$ setting in the SPI master controller. In other words, idle state of SCL is low and the SPI controller samples data in the rising edge of SCL. Besides single read/write cycle, the SPI salve controller also supports multiple read/ write cycles.
Figure 13, Figure 14, and Figure 15 show single and multiple read/write frame structures.


Figure 12. $I^{2}$ C Operating Mode State Diagram


Figure 13. SPI Timing Diagram


Figure 14. SPI Single Read/Write Frame Structure


Figure 15. SPI Multiple Read/Write Frame Structure

## Frame Structure

## Read/Write Bit (R/W)

The first bit indicates either read (0) or write (1) frame.

## Single/Multiple Bit (S/M)

The second bit determines either single read/write frame (0) or multiple read/write frame (1).

## Reserved Bits (RESERVED[3:0])

There are 4 reserved bits followed by read/write and single/multiple bits. The MAX77812 SPI slave controller ignores those bits.

## Address Bits (ADDR[9:0])

The SPI master controller loads 10 address bits on MOSI, however, the MAX77812 has only 8-bit address bus so that the SPI slave controller ignores attempt to access to overflowed addresses (beyond 0xFF).

## Packet Length Bits (PACKET_LENGTH[7:0])

The length of single read/write frame is organized as 32-bit (packet length bits are ignored).

For multiple read/write frame, PACKET_LENGTH[7:0] bits determine the number of data bytes. The total length of the multiple read/write frame is ' $32+8 \times \mathrm{n}$ ' bits, where ' $n$ ' is the packet length.

## Data Bits (RDATA[7:0]/WDATA[7:0])

The SPI slave controller has 8-bit data bus. While the slave controller is loading data onto MISO, it ignores the data on MOSI. When MISO is inactive, it is held low by the SPI slave controller.

## Multiple Write Cycles

Figure 16 is the timing diagram of multiple write cycle. The first data (WDATA0[7:0]) is written at ADDR[9:0] if the address is valid. For the next data byte, the register address automatically increases by one. The total number of data bytes are determined by PACKET_LENGTH[7:0] and the MAX77812 slave controller ignores the any data bytes beyond the total number of data bytes (PACKET_ LENGTH[7:0] + 1). While the SPI master controller is writing data onto MOSI, the SPI controller keeps MISO to a low state.

## Multiple Read Cycles

The timing diagram of multiple read cycle is shown in Figure 17. The first data (RDATA0[7:0]) is read at $\operatorname{ADDR}[9: 0]$ if the address is valid. For the next data byte, the register address automatically increases by one. The total number of data bytes are determined by PACKET_LENGTH[7:0] and the MAX77812 slave controller stops loading data beyond the total number of data
bytes (PACKET_LENGTH[7:0] + 1). While the SPI master controller is writing data onto MOSI, the MAX77812 SPI controller keeps MISO to a low state. When the SPI slave controller loads the data on MISO, the data on MOSI are ignored (don't care) by the SPI slave controller.
In case the SPI master controller tries to read nonexisting registers, the MAX77812 SPI slave controller returns zero values (MISO = low).


Figure 16. SPI Multiple Write Cycle


Figure 17. SPI Multiple Read Cycle
PMIC Registers
Register Reset Conditions
Type-S1: Registers are reset when $\mathrm{V}_{\text {SYS }}<$ POR ( $\approx 1.50 \mathrm{~V}$ )
Type-O: Registers are reset when $\mathrm{V}_{\text {SYS }}<\mathrm{V}_{\text {UVLO_F }}$ or $\mathrm{V}_{\mathrm{VIO}}<\mathrm{V}_{\text {TH_VIO_OK }}$ or $\mathrm{CE}=$ low or TOK $=$ low or SW_RST $=1$.
Register Map

| ADDR | REGISTER NAME | RESET TYPE | R/W | BIT7 | BIT6 | BIT5 | BIT4 | BIT3 | BIT2 | BIT1 | BITO | RESET VALUE |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 0x00 | REG_RESET | Type-O | W/C | RESERVED | RESERVED | RESERVED | RESERVED | RESERVED | RESERVED | RESERVED | SW_RST | 0x00 |
| 0x01 | INT_SRC | Type-O | R | RESERVED | RESERVED | RESERVED | RESERVED | RESERVED | RESERVED | BUCK_INT | TOPSYS <br> INT | 0x00 |
| 0x02 | INT_SRC_M | Type-O | R/W | RESERVED | RESERVED | RESERVED | RESERVED | RESERVED | RESERVED | $\begin{aligned} & \text { BUCK } \\ & \text { INT_M } \end{aligned}$ | $\begin{aligned} & \text { TOPSYS_ } \\ & \text { INT_M } \end{aligned}$ | 0x02 |
| 0x03 | TOPSYS_INT | Type-S1 | R/C | RESERVED | RESERVED | RESERVED | WDTRSTB <br> _INT | UVLO_INT | $\begin{aligned} & \text { TSHDN_ } \\ & \text { INT } \end{aligned}$ | $\begin{aligned} & \text { TJCT_- } \\ & \text { 140C_INT } \end{aligned}$ | $\begin{aligned} & \text { TJCT_} \\ & \text { 120C_INT } \end{aligned}$ | 0x00 |
| 0x04 | TOPSYS_INT_M | Type-O | R/W | RESERVED | RESERVED | RESERVED | WDTRSTB <br> _M | UVLO_M | TSHDN_M | $\begin{aligned} & \text { TJCT_- } \\ & \text { 140C_M } \end{aligned}$ | $\begin{aligned} & \text { TJCT_- } \\ & \text { 120C_M } \end{aligned}$ | 0x13 |
| 0x05 | TOPSYS_STAT | Type-O | R | RESERVED | RESERVED | RESERVED | RESERVED | UVLO | TSHDN | $\begin{aligned} & \text { TJCT_- } \\ & 140 \mathrm{C} \end{aligned}$ | $\begin{aligned} & \hline \text { TJCT_- } \\ & 120 \mathrm{C} \end{aligned}$ | - |
| 0x06 | EN_CTRL | Type-O | R/W | $\begin{gathered} \text { EN_M4_ } \\ \text { LPM } \end{gathered}$ | EN_M4 | $\begin{gathered} \text { EN_M3_ } \\ \text { LPM } \end{gathered}$ | EN_M3 | $\begin{gathered} \text { EN_M2_ } \\ \text { LPM } \end{gathered}$ | EN_M2 | $\begin{gathered} \text { EN_M1_ } \\ \text { LPM } \end{gathered}$ | EN_M1 | 0x00 |
| 0x07 | STUP_DLY1 | Type-O | R/W | DLY_STEP | RESERVED | RESERVED | M2_STUP_DLY[4:0] |  |  |  |  | 0x00 |
| 0x08 | STUP_DLY2 | Type-O | R/W | RESERVED | RESERVED | RESERVED | M3_STUP_DLY[4:0] |  |  |  |  | $0 \times 00$ |
| 0x09 | STUP_DLY3 | Type-O | R/W | RESERVED | RESERVED | RESERVED | M4_STUP_DLY[4:0] |  |  |  |  | $0 \times 00$ |
| 0x0A | SHDN_DLY1 | Type-O | R/W | RESERVED | RESERVED | RESERVED | M1_SHDN_DLY[4:0] |  |  |  |  | $0 \times 00$ |
| 0x0B | SHDN_DLY2 | Type-O | R/W | RESERVED | RESERVED | RESERVED | M2_SHDN_DLY[4:0] |  |  |  |  | 0x00 |
| 0x0C | SHDN_DLY3 | Type-O | R/W | RESERVED | RESERVED | RESERVED | M3_SHDN_DLY[4:0] |  |  |  |  | $0 \times 00$ |
| 0x0D | SHDN_DLY4 | Type-O | R/W | RESERVED | RESERVED | RESERVED | M4_SHDN_DLY[4:0] |  |  |  |  | $0 \times 00$ |
| 0x0E | WDTRSTB_DEB | Type-O | R/W | RESERVED | RESERVED | RESERVED | RESERVED | RESERVED | WDT_DEB[2:0] |  |  | 0x02 |
| 0x0F | GPI_FUNC | Type-O | R/W | GPI1_FUNC[3:0] |  |  |  | GPIO_FUNC[3:0] |  |  |  | 0x43 |
| 0x10 | GPI_DEB1 | Type-O | R/W | LPM_DEB[2:0] |  |  |  | EN_DEB[2:0] |  |  |  | 0x11 |
| 0x11 | GPI_DEB2 | Type-O | R/W | GPI1_DEB[2:0] |  |  |  | GPIO_DEB[2:0] |  |  |  | 0x11 |
| 0x12 | GPI_PD_CTRL | Type-O | R/W | RESERVED | RESERVED | RESERVED | RESERVED | LPM_PD | EN_PD | GPI1_PD | GPIO_PD | 0x0F |
| 0x13 | PROT_CFG | Type-O | R/W | TSHDN_EN | RESERVED | RESERVED | RESERVED | RESERVED | UVLO_F[2:0] |  |  | 0x82 |
| 0x15 | I2C_CFG | Type-O | R/W | RESERVED | RESERVED | RESERVED | RESERVED | RESERVED | RESERVED | PAIR | HS_EXT | 0x00 |
| $\begin{array}{\|c} 0 \times 16- \\ 0 \times 1 F \end{array}$ | RESERVED |  |  |  |  |  |  |  |  |  |  |  |

Register Map (continued)

| ADDR | REGISTER NAME | RESET <br> TYPE | R/W | BIT7 | BIT6 | BIT5 | BIT4 | BIT3 | BIT2 | BIT1 | BITO | RESET VALUE |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 0x20 | BUCK_INT | Type-S1 | R/C | RESERVED | RESERVED | RESERVED | RESERVED | M4_POKn _INT | $\begin{gathered} \text { M3_POKn } \\ \text { _INT } \\ \hline \end{gathered}$ | M2_POKn <br> _INT | $\begin{gathered} \mathrm{M} 1 \_ \\ \mathrm{POKn} \_\mathrm{INT} \end{gathered}$ | 0x00 |
| 0x21 | BUCK_INT_M | Type-O | R/W | RESERVED | RESERVED | RESERVED | RESERVED | $\begin{gathered} \text { M4_POKn } \\ \text { _M } \end{gathered}$ | $\begin{gathered} \text { M3_POKn } \\ \text { _M } \end{gathered}$ | M2_POKn_M | $\begin{gathered} \mathrm{M} 1 \_- \\ \text {POKn_M } \end{gathered}$ | 0x0F |
| 0x22 | BUCK_STAT | Type-O | R | RESERVED | RESERVED | RESERVED | RESERVED | M4_POKn | M3_POKn | M2_POKn | M1_POKn | - |
| 0x23 | M1_VOUT | Type-O | R/W | M1_VOUT[7:0] |  |  |  |  |  |  |  | 0x50 |
| 0x24 | M2_VOUT | Type-O | R/W | M2_VOUT[7:0] |  |  |  |  |  |  |  | 0x50 |
| 0x25 | M3_VOUT | Type-O | R/W | M3_VOUT[7:0] |  |  |  |  |  |  |  | 0x46 |
| 0x26 | M4_VOUT | Type-O | R/W | M4_VOUT[7:0] |  |  |  |  |  |  |  | 0x46 |
| 0x27 | M1_VOUT_D | Type-O | R/W | M1_VOUT_D[7:0] |  |  |  |  |  |  |  | 0x78 |
| 0x28 | M2_VOUT_D | Type-O | R/W | M2_VOUT_D[7:0] |  |  |  |  |  |  |  | 0x78 |
| 0x29 | M3_VOUT_D | Type-O | R/W | M3_VOUT_D[7:0] |  |  |  |  |  |  |  | 0x78 |
| 0x2A | M4_VOUT_D | Type-O | R/W | M4_VOUT_D[7:0] |  |  |  |  |  |  |  | 0x78 |
| 0x2B | M1_VOUT_S | Type-O | R/W | M1_VOUT_S[7:0] |  |  |  |  |  |  |  | 0x1E |
| 0x2C | M2_VOUT_S | Type-O | R/W | M2_VOUT_S[7:0] |  |  |  |  |  |  |  | 0x1E |
| 0x2D | M3_VOUT_S | Type-O | R/W | M3_VOUT_S[7:0] |  |  |  |  |  |  |  | 0x1E |
| 0x2E | M4_VOUT_S | Type-O | R/W | M4_VOUT_S[7:0] |  |  |  |  |  |  |  | 0x1E |
| 0x2F | M1_CGF | Type-O | R/W | M1_AD | M1_ILIM[2:0] |  |  | RESERVED |  | M1_FPWM | $\begin{gathered} \text { M1 }- \\ \text { FSREN } \end{gathered}$ | 0xD1 |
| 0x30 | M2_CGF | Type-O | R/W | M2_AD | M2_ILIM[2:0] |  |  | RESERVED |  | M2_FPWM | $\begin{gathered} \text { M2 } \\ \text { FSREN } \end{gathered}$ | 0xD1 |
| 0x31 | M3_CGF | Type-O | R/W | M3_AD | M3_ILIM[2:0] |  |  | RESERVED |  | M3_FPWM | $\begin{gathered} \text { M3_ } \\ \text { FSREN } \end{gathered}$ | 0xD1 |
| 0x32 | M4_CGF | Type-O | R/W | M4_AD | M4_ILIM[2:0] |  |  | RESERVED |  | M4_FPWM | $\begin{gathered} \text { M4_- } \\ \text { FSREEN } \end{gathered}$ | 0xD1 |
| 0x33 | GLB_CFG1 | Type-O | R/W | RESERVED | B_SD_SR[2:0] |  |  | RESERVED | B_SS_SR[2:0] |  |  | 0x24 |
| 0x34 | GLB_CFG2 | Type-O | R/W | RESERVED | B_RD_SR[2:0] |  |  | RESERVED | B_RU_SR[2:0] |  |  | 0x24 |
| 0x35 | GLB_CFG3 | Type-O | R/W | RESERVED | RESERVED | RESERVED | RESERVED | RESERVED | RESERVED | $\begin{gathered} \text { B_PETR_ } \\ \text { EN } \end{gathered}$ | $\underset{\text { EN }}{\mathrm{B}_{2} \text { NETR_ }}$ | 0x5F |
| $\begin{gathered} 0 \times 36- \\ 0 \times F F \end{gathered}$ | RESERVED |  |  |  |  |  |  |  |  |  |  |  |

[^1]W/C: Write and clear

REG_RESET Register Reset Control Register

| ADDRESS | MODE |  | TYPE: $\mathbf{O}$ | RESET VALUE: 0x00 |
| :---: | :---: | :---: | :---: | :---: |
| $\mathbf{0 x 0 0}$ | NAME | POR |  |  |
| BIT | RESERVED | 0000000 |  |  |
| $7: 1$ | SW_RST | 0 | Type-O Register Reset Control <br> 1: Reset all Type-O registers to their POR default values. <br> This bit clears to ' 0 ' upon reset. |  |
| 0 |  |  |  |  |

INT_SRC Interrupt Source Register

| ADDRESS | MODE |  | TYPE: $\mathbf{0}$ | RESET VALUE: 0x00 |
| :---: | :---: | :---: | :---: | :---: |
| $\mathbf{0 x 0 1}$ | NAME | POR |  |  |
| BIT | RESERVED | 000000 |  |  |
| $7: 2$ | BUCK_INT | 0 | $1:$ DESCRIPTION |  |
| 1 | TOPSYS_INT | 0 | $1:$ Interrupt event on BUCK is detected |  |
| 0 |  | 0 |  |  |

INT_SRC_M Interrupt Source Mask Register

| ADDRESS | MODE |  | TYPE: $\mathbf{O}$ | RESET VALUE: 0x02 |
| :---: | :---: | :---: | :---: | :---: |
| $\mathbf{0 x 0 2}$ | NAME | POR |  | DESCRIPTION |
| BIT | RESERVED | 000000 |  |  |
| $7: 4$ | BUCK_INT_M | 1 | 0: Enable BUCK_INT <br> $1:$ Mask BUCK_INT |  |
| 1 | TOPSYS_INT_M | 0 | 0: Enable TOPSYS_INT <br> $1:$ Mask TOPSYS_INT |  |
| 0 |  |  |  |  |

## TOPSYS_INT TOPSYS Interrupt Register

| ADDRESS | MODE |  | TYPE: $\mathbf{S 1}$ | RESET VALUE: 0x00 |
| :---: | :---: | :---: | :---: | :---: |
| $\mathbf{0 x 0 3}$ | NAME | POR |  |  |
| BIT | RESERVED | 000 |  |  |
| $7: 5$ | WDTRSTB_INT | 0 | $1:$ WDTRSTB interrupt has triggered. |  |
| 4 | UVLO_INT | 0 | $1:$ UVLO interrupt has triggered. |  |
| 3 | TSHDN_INT | 0 | $1:$ TSHDN interrupt has triggered. |  |
| 2 | TJCT_140C_INT | 0 | $1:$ TJCT_140C interrupt has triggered. |  |
| 1 | TJCT_120C_INT | 0 | $1:$ TJCT_120C interrupt has triggered. |  |
| 0 |  |  |  |  |

TOPSYS_INT_M TOPSYS Interrupt Mask Register

| ADDRESS | MODE |  | TYPE: $\mathbf{O}$ | RESET VALUE: 0x13 |
| :---: | :---: | :---: | :---: | :---: |
| $\mathbf{0 x 0 4}$ | NAME | POR |  |  |
| BIT | RESERVED | 000 |  |  |
| $7: 5$ | WDTRSTB_M | 1 | 0: Enable WDTRSTB_INT. <br> 1: Mask WDTRSTB_INT. |  |
| 4 | UVLO_M | 0 | 0: Enable UVLO_INT. <br> $1:$ Mask UVLO_INT. |  |
| 3 | TSHDN_M | 0 | 0: Enable TSHDN_INT. <br> $1:$ Mask TSHDN_INT. |  |
| 2 | TJCT_140C_M | 1 | 0: Enable TJCT_140C_INT. <br> $1:$ Mask TJCT_140C_INT. |  |
| 1 | TJCT_120C_M | 1 | 0: Enable TJCT_120C_INT. <br> $1:$ Mask TJCT_120C_INT. |  |
| 0 |  |  |  |  |

TOPSYS_STAT TOPSYS Status Register

| ADDRESS | MODE |  | TYPE: O | RESET VALUE: N/A |
| :---: | :---: | :---: | :---: | :---: |
| 0x05 | R |  |  |  |
| BIT | NAME | POR | DESCRIPTION |  |
| 7:4 | RESERVED | - |  |  |
| 3 | UVLO | - | $\begin{array}{\|l\|} \hline 0: V_{\text {SYS }} \geq V_{U V L O} \\ \text { 1: } V_{\text {SYS }}<V_{U V L O} \\ \hline \end{array}$ |  |
| 2 | TSHDN | - | 0 : Junction Temperature $\left(T_{J C T}\right) \leq+165^{\circ} \mathrm{C}$ <br> 1: Junction Temperature $\left(T_{J C T}\right)>+165^{\circ} \mathrm{C}$ |  |
| 1 | TJCT_140C | - | 0 : Junction Temperature $\left(\mathrm{T}_{\mathrm{JCT}}\right) \leq+140^{\circ} \mathrm{C}$ <br> 1: Junction Temperature $\left(T_{J} C T\right)>+140^{\circ} \mathrm{C}$ |  |
| 0 | TJCT_120C | - | 0 : Junction Temperature $\left(\mathrm{T}_{\mathrm{JCT}}\right) \leq+120^{\circ} \mathrm{C}$ <br> 1: Junction Temperature $\left(\mathrm{T}_{\mathrm{JCT}}\right)>+120^{\circ} \mathrm{C}$ |  |

## EN_CTRL Regulator Enable Control Register

| ADDRESS | MODE |  | TYPE: 0 | RESET VALUE: 0x00 |
| :---: | :---: | :---: | :---: | :---: |
| 0x06 | R/W |  |  |  |
| BIT | NAME | POR | DESCRIPTION |  |
| 7 | EN_M4_LPM | 0 | 0: Disable BUCK Master 4 low power mode. <br> 1: Enable BUCK Master 4 low power mode. |  |
| 6 | EN_M4 | 0 | 0: Disable BUCK Master 4 output. <br> 1: Enable BUCK Master 4 output ('OR' logic with GPIx input). |  |
| 5 | EN_M3_LPM | 0 | 0: Disable BUCK Master 3 low power mode. <br> 1: Enable BUCK Master 3 low power mode. |  |
| 4 | EN_M3 | 0 | 0: Disable BUCK Master 3 output. <br> 1: Enable BUCK Master 3 output ('OR’ logic with GPIx input). |  |
| 3 | EN_M2_LPM | 0 | 0: Disable BUCK Master 2 low power mode. <br> 1: Enable BUCK Master 2 low power mode. |  |
| 2 | EN_M2 | 0 | 0 : Disable BUCK Master 2 output. <br> 1: Enable BUCK Master 2 output ('OR' logic with GPIx input). |  |
| 1 | EN_M1_LPM | 0 | 0: Disable BUCK Master 1 low power mode. <br> 1: Enable BUCK Master 1 low power mode. |  |
| 0 | EN_M1 | 0 | 0 : Disable BUCK Master 1 output. <br> 1: Enable BUCK Master 1 output ('OR’ logic with GPIx input). |  |

## STUP_DLY1 Global Startup Delay Setting Register 1

| ADDRESS | MODE |  | TYPE: O (OTP) | RESET VALUE: 0x00 |
| :---: | :---: | :---: | :---: | :---: |
| 0x07 | R/W |  |  |  |
| BIT | NAME | POR | DESCRIPTION |  |
| 7 | DLY_STEP | 0 | Delay Time Step Selection <br> $0: 1 \mathrm{~ms}$ <br> 1: 2 ms |  |
| 6:5 | RESERVED | 00 |  |  |
| 4:0 | M2_STUP_DLY[4:0] | 00000 | BUCK Master 2 Startup Delay Time Setting (Delay from Rising Edge of EN Pin or GLB_EN) <br> $00000 \mathrm{~b}=0 \mathrm{~ms}$ <br> $00001 \mathrm{~b}=1 \mathrm{x}$ DLY_STEP <br> $00010 \mathrm{~b}=2 \times$ DLY_STEP <br> 1 1110b = $30 \times$ DLY_STEP <br> $11111 \mathrm{~b}=31 \times$ DLY STEP |  |

## STUP_DLY2 Global Startup Delay Setting Register 2

| ADDRESS | MODE |  | TYPE: O (OTP) | RESET VALUE: 0x00 |
| :---: | :---: | :---: | :---: | :---: |
| 0x08 | R/W |  |  |  |
| BIT | NAME | POR | DESCRIPTION |  |
| 7:5 | RESERVED | 000 |  |  |
| 4:0 | M3_STUP_DLY[4:0] | 00000 | BUCK Master 3 Startup Delay Time Setting (Delay from Rising Edge of EN Pin or GLB_EN) <br> $00000 \mathrm{~b}=0 \mathrm{~ms}$ <br> $00001 \mathrm{~b}=1 \times$ DLY_STEP <br> $00010 \mathrm{~b}=2 \times$ DLY_STEP <br> $11110 \mathrm{~b}=30 \times$ DLY_STEP <br> $11111 \mathrm{~b}=31 \times$ DLY_STEP |  |

## STUP_DLY3 Global Startup Delay Setting Register 3

| ADDRESS | MODE |  | TYPE: O (OTP) | RESET VALUE: 0x00 |
| :---: | :---: | :---: | :---: | :---: |
| 0x09 | R/W |  |  |  |
| BIT | NAME | POR | DESCRIPTION |  |
| 7:5 | RESERVED | 000 |  |  |
| 4:0 | M4_STUP_DLY[4:0] | 00000 | BUCK Master 4 Startup Delay Time Setting (Delay from Rising Edge of EN Pin or GLB_EN) <br> $00000 \mathrm{~b}=0 \mathrm{~ms}$ <br> 0 0001b $=1 \times$ DLY_STEP <br> 0 0010b $=2 \times$ DLY_STEP $\begin{aligned} & 11110 \mathrm{~b}=30 \times \text { DLY_STEP } \\ & 11111 \mathrm{~b}=31 \times \text { DLY_STEP } \end{aligned}$ |  |

## SHDN_DLY1 Global Shutdown Delay Setting Register 1

| ADDRESS | MODE |  | TYPE: 0 | RESET VALUE: 0x00 |
| :---: | :---: | :---: | :---: | :---: |
| 0x0A | R/W |  |  |  |
| BIT | NAME | POR | DESCRIPTION |  |
| 7:5 | RESERVED | 000 |  |  |
| 4:0 | M1_SHDN_DLY[4:0] | 00000 | BUCK Master 1 Shutdown Delay Time Setting (Delay from Falling Edge of EN Pin or GLB_EN) <br> $00000 \mathrm{~b}=0 \mathrm{~ms}$ <br> $00001 \mathrm{~b}=1 \times$ DLY_STEP <br> $00010 \mathrm{~b}=2 \times$ DLY_STEP <br> $11110 \mathrm{~b}=30 \times$ DLY_STEP <br> $11111 \mathrm{~b}=31 \times$ DLY_STEP |  |

SHDN_DLY2 Global Shutdown Delay Setting Register 2

| ADDRESS | MODE |  | TYPE: 0 | RESET VALUE: 0x00 |
| :---: | :---: | :---: | :---: | :---: |
| 0x0B | R/W |  |  |  |
| BIT | NAME | POR | DESCRIPTION |  |
| 7:5 | RESERVED | 000 |  |  |
| 4:0 | M2_SHDN_DLY[4:0] | 00000 | BUCK Master 2 Shutdown Delay Time Setting (Delay from Falling <br> Edge of EN Pin or GLB_EN) <br> $00000 \mathrm{~b}=0 \mathrm{~ms}$ <br> $00001 \mathrm{~b}=1 \mathrm{x}$ DLY_STEP <br> $00010 \mathrm{~b}=2 \times$ DLY_STEP <br> $11110 \mathrm{~b}=30 \times$ DLY_STEP <br> $11111 \mathrm{~b}=31 \times$ DLY_STEP |  |

## SHDN_DLY3 Global Shutdown Delay Setting Register 3

| ADDRESS | MODE |  | TYPE: 0 | RESET VALUE: 0x00 |
| :---: | :---: | :---: | :---: | :---: |
| 0x0C | R/W |  |  |  |
| BIT | NAME | POR | DESCRIPTION |  |
| 7:5 | RESERVED | 000 |  |  |
| 4:0 | M3_SHDN_DLY[4:0] | 00000 | BUCK Master <br> Edge of EN P $00000 \mathrm{~b}=0 \mathrm{~m}$ <br> $00001 \mathrm{~b}=1 \mathrm{x}$ $00010 b=2 x$ $\begin{aligned} & 11110 b=30 \\ & 11111 b=31 \end{aligned}$ | Time Setting (Delay from Falling |

## SHDN_DLY4 Global Shutdown Delay Setting Register 4

| ADDRESS | MODE |  | TYPE: 0 | RESET VALUE: 0x00 |
| :---: | :---: | :---: | :---: | :---: |
| 0x0D | R/W |  |  |  |
| BIT | NAME | POR | DESCRIPTION |  |
| 7:5 | RESERVED | 000 |  |  |
| 4:0 | M4_SHDN_DLY[4:0] | 00000 | BUCK Master 4 Shutdown Delay Time Setting (Delay from Falling <br> Edge of EN Pin or GLB_EN) <br> $00000 \mathrm{~b}=0 \mathrm{~ms}$ <br> $00001 \mathrm{~b}=1 \times$ DLY_STEP <br> $00010 b=2 \times$ DLY_STEP <br> $11110 \mathrm{~b}=30 \times$ DLY_STEP <br> $11111 \mathrm{~b}=31$ x DLY_STEP |  |

WDTRSTB_DEB WDTRSTB_IN Input Debounce Time Setting Register


## GPI_FUNC GPI Function Selection Register

| ADDRESS | MODE |  | TYPE: 0 | RESET VALUE: 0x43 |
| :---: | :---: | :---: | :---: | :---: |
| 0x0F | R/W |  |  |  |
| BIT | NAME | POR | DESCRIPTION |  |
| 7:4 | GPI1_FUNC[3:0] | 0100 | GPI1 Function Sele 0000b: GLB_EN 0001b: M1_EN 0010b: M2_EN 0011b: M3_EN 0100b: M4_EN 0101b: GLB_VSEL 0110b: M1_VSEL 0111b: M2_VSEL | tion <br> 1000b: M3_VSEL 1001b: M4_VSEL 1010b: GLB_LPM 1011b: M1_LPM 1100b: M2_LPM 1101b: M3_LPM 1110b: M4_LPM 1111b: No Function |
| 3:0 | GPIO_FUNC[3:0] | 0011 | GPIO Function Sele 0000b: GLB_EN 0001b: M1_EN 0010b: M2_EN 0011b: M3_EN 0100b: M4_EN 0101b: GLB_VSEL 0110b: M1_VSEL 0111b: M2_VSEL | tion <br> 1000b: M3_VSEL 1001b: M4_VSEL 1010b: GLB_LPM 1011b: M1_LPM 1100b: M2_LPM 1101b: M3_LPM 1110b: M4_LPM 1111b: No Function |

## GPI_DEB1 GPI Debounce Time Setting Register 1

| ADDRESS | MODE |  | TYPE: 0 | RESET VALUE: 0x11 |  |
| :---: | :---: | :---: | :---: | :---: | :---: |
| $0 \times 10$ | R/W |  |  |  |  |
| BIT | NAME | POR | DESCRIPTION |  |  |
| 7:4 | LPM_DEB[3:0] | 0001 | LPM Debounce 0000b $=0 \mu \mathrm{~s}$ $0001 b=64 \mu s$ $0010 \mathrm{~b}=128 \mu \mathrm{~s}$ $0011 \mathrm{~b}=192 \mu \mathrm{~s}$ $0100 \mathrm{~b}=256 \mu \mathrm{~s}$ $0101 \mathrm{~b}=320 \mu \mathrm{~s}$ 0110b $=384 \mu \mathrm{~s}$ 0111b $=448 \mu s$ | $\begin{aligned} & \text { ne Setting } \\ & 1000 \mathrm{~b}=512 \mu \mathrm{~s} \\ & 1001 \mathrm{~b}=576 \mu \mathrm{~s} \\ & 1010 \mathrm{~b}=640 \mu \mathrm{~s} \\ & 1011 \mathrm{~b}=704 \mu \mathrm{~s} \\ & 1100 \mathrm{~b}=768 \mu \mathrm{~s} \\ & 1101 \mathrm{~b}=832 \mu \mathrm{~s} \\ & 1110 \mathrm{~b}=896 \mu \mathrm{~s} \\ & 1111 \mathrm{~b}=960 \mu \mathrm{~s} \end{aligned}$ |  |
| 3:0 | EN_DEB[3:0] | 0001 | EN Debounce 0000b $=0 \mu \mathrm{~s}$ $0001 b=64 \mu s$ $0010 \mathrm{~b}=128 \mu \mathrm{~s}$ $0011 \mathrm{~b}=192 \mu \mathrm{~s}$ $0100 \mathrm{~b}=256 \mu \mathrm{~s}$ $0101 \mathrm{~b}=320 \mu \mathrm{~s}$ $0110 \mathrm{~b}=384 \mu \mathrm{~s}$ $0111 \mathrm{~b}=448 \mu \mathrm{~s}$ | Setting $1000 \mathrm{~b}=512 \mu \mathrm{~s}$ $1001 \mathrm{~b}=576 \mu \mathrm{~s}$ $1010 b=640 \mu s$ $1011 b=704 \mu s$ $1100 b=768 \mu s$ $1101 \mathrm{~b}=832 \mu \mathrm{~s}$ $1110 b=896 \mu s$ $1111 b=960 \mu s$ |  |

## GPI_DEB2 GPI Debounce Time Setting Register 2

| ADDRESS | MODE |  | TYPE: O | RESET VALUE: 0x11 |  |
| :---: | :---: | :---: | :---: | :---: | :---: |
| 0x11 | R/W |  |  |  |  |
| BIT | NAME | POR | DESCRIPTION |  |  |
| 7:4 | GPI1_DEB[3:0] | 0001 | GPI1 Debounce $0000 \mathrm{~b}=0 \mu \mathrm{~s}$ $0001 b=64 \mu s$ $0010 \mathrm{~b}=128 \mu \mathrm{~s}$ 0011b $=192 \mu s$ $0100 \mathrm{~b}=256 \mu \mathrm{~s}$ 0101b $=320 \mu s$ 0110b $=384 \mu s$ $0111 b=448 \mu s$ | $\begin{aligned} & \text { ne Setting } \\ & 1000 \mathrm{~b}=512 \mu \mathrm{~s} \\ & 1001 \mathrm{~b}=576 \mu \mathrm{~s} \\ & 1010 \mathrm{~b}=640 \mu \mathrm{~s} \\ & 1011 \mathrm{~b}=704 \mu \mathrm{~s} \\ & 1100 \mathrm{~b}=768 \mu \mathrm{~s} \\ & 1101 \mathrm{~b}=832 \mu \mathrm{~s} \\ & 1110 \mathrm{~b}=896 \mu \mathrm{~s} \\ & 1111 \mathrm{~b}=960 \mu \mathrm{~s} \end{aligned}$ |  |
| 3:0 | GPIO_DEB[3:0] | 0001 | $\begin{aligned} & \text { GPIO Debounce } \\ & 0000 \mathrm{~b}=0 \mu \mathrm{~s} \\ & 0001 \mathrm{~b}=64 \mu \mathrm{~s} \\ & 0010 \mathrm{~b}=128 \mu \mathrm{~s} \\ & 0011 \mathrm{~b}=192 \mu \mathrm{~s} \\ & 0100 \mathrm{~b}=256 \mu \mathrm{~s} \\ & 0101 \mathrm{~b}=320 \mu \mathrm{~s} \\ & 0110 \mathrm{~b}=384 \mu \mathrm{~s} \\ & 0111 \mathrm{~b}=448 \mu \mathrm{~s} \end{aligned}$ | $\begin{aligned} & \text { ne Setting } \\ & 1000 \mathrm{~b}=512 \mu \mathrm{~s} \\ & 1001 \mathrm{~b}=576 \mu \mathrm{~s} \\ & 1010 \mathrm{~b}=640 \mu \mathrm{~s} \\ & 1011 \mathrm{~b}=704 \mu \mathrm{~s} \\ & 1100 \mathrm{~b}=768 \mu \mathrm{~s} \\ & 1101 \mathrm{~b}=832 \mu \mathrm{~s} \\ & 1110 \mathrm{~b}=896 \mu \mathrm{~s} \\ & 1111 \mathrm{~b}=960 \mu \mathrm{~s} \end{aligned}$ |  |

## GPI_PD_CTRL GPI Pulldown Resistor Control Register

| ADDRESS | MODE |  | TYPE: $\mathbf{O}$ | RESET VALUE: 0x0F |
| :---: | :---: | :---: | :--- | :--- |
| $\mathbf{0 x 1 2}$ | NAME | POR |  |  |
| BIT | RESERVED | 0000 | DESCRIPTION |  |
| $7: 4$ | LPM_PD | 1 | LPM Input Pulldown Resistor Enable Setting <br> 0: Disable <br> $1:$ Enable |  |
| 3 | EN_PD | 1 | EN Input Pulldown Resistor Enable Setting <br> 0: Disable <br> 1: Enable |  |
| 2 | GPI1_PD | 1 | GPI1 Input Pulldown Resistor Enable Setting <br> 0: Disable <br> 1: Enable |  |
| 1 | GPIO_PD | 1 | GPIO Input Pulldown Resistor Enable Setting <br> 0: Disable <br> $1:$ Enable |  |
| 0 |  |  |  |  |

## PROT_CFG Protection Configuration Register

| ADDRESS | MODE |  | TYPE: 0 | RESET VALUE: 0x82 |
| :---: | :---: | :---: | :---: | :---: |
|  | R/W |  |  |  |
| BIT | NAME | POR | DESCRIPTION |  |
| 7 | TSHDN_EN | 1 | Thermal Protection Enable Control 0: Disable (TSHDN_INT is not disabled) <br> 1: Enable |  |
| 6:3 | RESERVED | 0000 |  |  |
| 2:0 | UVLO_F[2:0] | 010 | $\mathrm{V}_{\mathrm{SYS}}$ UVLO Falli $000 \mathrm{~b}=1.95 \mathrm{~V}$ $001 \mathrm{~b}=2.05 \mathrm{~V}$ $010 \mathrm{~b}=2.15 \mathrm{~V}$ $011 \mathrm{~b}=2.25 \mathrm{~V}$ $100 \mathrm{~b}=2.35 \mathrm{~V}$ $101 \mathrm{~b}=2.45 \mathrm{~V}$ $110 \mathrm{~b}=2.55 \mathrm{~V}$ 111b = Disabled |  |

[^2]
## I2C_CFG I²C Configuration Register

| ADDRESS | MODE |  | TYPE: $\mathbf{O}$ | RESET VALUE: 0x00 |
| :---: | :---: | :---: | :--- | :--- |
| $\mathbf{0 x 1 5}$ | NAME | POR |  |  |
| BIT | RESERVED | NA |  |  |
| $7: 4$ | RESERVED | 00 | DESCRIPTION |  |
| $3: 2$ | PAIR '00' | 0 | Register Data Pair Mode <br> $0:$ Disable (Sequential Mode) <br> 1: Enable |  |
| 1 | HS_EXT | 0 | HS Mode Extension <br> 0: Disable HS mode extension (I2C Rev. 4 Compliant). <br> 1: Enable HS mode extension. <br> (HS mode is extended during/after 'STOP' condition.) |  |
| 0 |  |  |  |  |

0x16-0x1F: RESERVED

## BUCK_INT Regulators Interrupt Register

| ADDRESS | MODE |  | TYPE: S1 | RESET VALUE: 0x00 |
| :---: | :---: | :---: | :---: | :---: |
| 0x20 | R/C |  |  |  |
| BIT | NAME | POR | DESCRIPTION |  |
| 7:4 | RESERVED | 0000 |  |  |
| 3 | M4_POK_INT | 0 | 1: BUCK Master $4 \overline{\mathrm{POK}}$ interrupt has triggered. |  |
| 2 | M3_POK_INT | 0 | 1: BUCK Master 3 POK interrupt has triggered. |  |
| 1 | M2_POK_INT | 0 | 1: BUCK Master $2 \overline{\text { POK }}$ interrupt has triggered. |  |
| 0 | M1_POK_INT | 0 | 1: BUCK Master $1 \overline{\mathrm{POK}}$ interrupt has triggered. |  |

## BUCK_INT_M BUCK Interrupt Mask Register



BUCK_STAT BUCK Status Register


M1_VOUT BUCK Master1 Output Voltage Setting Register

| ADDRESS | MODE |  | TYPE: 0 <br> (OTP) | RESET VALUE: 0x50 |
| :---: | :---: | :---: | :---: | :---: |
| $\mathbf{0 \times 2 3}$ | R/W | POR |  |  |
| BIT | NAME | DESCRIPTION |  |
| $7: 0$ | M1_VOUT[7:0] | 01010000 | BUCK Master 1 Output Voltage |  |

M2_VOUT BUCK Master 2 Output Voltage Setting Register

| ADDRESS | MODE |  | TYPE: $\mathbf{O}$ <br> (OTP) | RESET VALUE: 0x50 |
| :---: | :---: | :---: | :---: | :---: |
| 0x24 | NAME | POR |  |  |
| BIT | M2_VOUT[7:0] | 01010000 | DESCRIPTION |  |
| $7: 0$ | BUCK Master 2 Output Voltage |  |  |  |

M3_VOUT BUCK Master 3 Output Voltage Setting Register

| ADDRESS | MODE |  | TYPE: 0 <br> (OTP) | RESET VALUE: 0x46 |
| :---: | :---: | :---: | :---: | :---: |
| $\mathbf{0 x 2 5}$ | R/W | POR |  |  |
| BIT | NAME | DESCRIPTION |  |
| $7: 0$ | M3_VOUT[7:0] | 01000110 | BUCK Master 3 Output Voltage |  |

## M4_VOUT BUCK Master 4 Output Voltage Setting Register

| ADDRESS | MODE |  | TYPE: 0 <br> (OTP) | RESET VALUE: 0x46 |
| :---: | :---: | :---: | :---: | :---: |
| 0x26 | R/W |  |  |  |
| BIT | NAME | DESCRIPTION |  |
| $7: 0$ | M4_VOUT[7:0] | 01000110 | BUCK Master 4 Output Voltage |  |

M1_VOUT_D BUCK Master 1 Default Output Voltage Setting Register

| ADDRESS | MODE |  | TYPE: 0 | RESET VALUE: 0x78 |
| :---: | :---: | :---: | :---: | :---: |
| 0x27 | R/W | POR |  |  |
| BIT | NAME | DESCRIPTION |  |
| $7: 0$ | M1_VOUT_D[7:0] | 01111000 | Buck Master 1 Default Output Voltage. Sets the output voltage when <br> DVS $=1$ through a GPI. |  |

## M2_VOUT_D BUCK Master 2 Default Output Voltage Setting Register

| ADDRESS | MODE |  | TYPE: $\mathbf{O}$ | RESET VALUE: 0x78 |
| :---: | :---: | :---: | :---: | :---: |
| 0x28 | R/W |  |  |  |
| BIT | NAME | DESCRIPTION |  |
| $7: 0$ | M2_VOUT_D[7:0] | 01111000 | Buck Master 2 Default Output Voltage. Sets the output voltage when <br> DVS $=1$ through a GPI. |  |

## M3_VOUT_D BUCK Master 3 Default Output Voltage Setting Register

| ADDRESS | MODE |  | TYPE: O | RESET VALUE: 0x78 |
| :---: | :---: | :---: | :---: | :---: |
| $0 \times 29$ | R/W | POR |  | DESCRIPTION |  |
| BIT | NAME | 01111000 | Buck Master 3 Default Output Voltage. Sets the output voltage when <br> DVS $=1$ through a GPI. |  |
| $7: 0$ | M3_VOT_D[7:0] |  |  |  |

## M4_VOUT_D BUCK Master 4 Default Output Voltage Setting Register

| ADDRESS | MODE |  | TYPE: 0 | RESET VALUE: 0x78 |
| :---: | :---: | :---: | :---: | :---: |
| 0x2A | R/W |  |  |  |
| BIT | NAME | DESCRIPTION |  |
| $7: 0$ | M4_VOUT_D[7:0] | 01111000 | Buck Master 4 Default Output Voltage. Sets the output voltage when <br> DVS $=1$ through a GPI. |  |

M1_VOUT_S BUCK Master1 Sleep Mode Output Voltage Setting Register

| ADDRESS | MODE |  | TYPE: 0 | RESET VALUE: 0x1E |
| :---: | :---: | :---: | :---: | :---: |
| 0x2B | R/W | POR |  |  |
| BIT | NAME | DESCRIPTION |  |
| $7: 0$ | M1_VOUT_S[7:0] | 00011110 | Buck Master 1 Sleep Mode Output Voltage. Sets the output voltage <br> when DVS $=0$ through a GPI. |  |

## M2_VOUT_S BUCK Master 2 Sleep Mode Output Voltage Setting Register

| ADDRESS | MODE |  | TYPE: 0 | RESET VALUE: 0x1E |
| :---: | :---: | :---: | :---: | :---: |
| 0x2C | NAME | POR |  | DESCRIPTION |  |
| BIT | M2_VOUT_S[7:0] | 00011110 | Buck Master 2 Sleep Mode Output Voltage. Sets the output voltage <br> when DVS $=0$ through a GPI. |  |
| $7: 0$ |  |  |  |  |

## M3_VOUT_S BUCK Master 3 Sleep Mode Output Voltage Setting Register

| ADDRESS | MODE |  | TYPE: 0 | RESET VALUE: 0x1E |
| :---: | :---: | :---: | :---: | :---: |
| 0x2D | R/W | POR |  |  |
| BIT | NAME | DESCRIPTION |  |
| $7: 0$ | M3_VOUT_S[7:0] | 00011110 | Buck Master 3 Sleep Mode Output Voltage. Sets the output voltage <br> when DVS $=0$ through a GPI. |  |

## M4_VOUT_S BUCK Master 4 Sleep Mode Output Voltage Setting Register

| ADDRESS | MODE |  | TYPE: 0 | RESET VALUE: 0x1E |
| :---: | :---: | :---: | :---: | :---: |
| 0x2E | R/W |  |  |  |
| BIT | NAME | DESCRIPTION |  |
| $7: 0$ | M4_VOUT_S[7:0] | 00011110 | Buck Master 4 Sleep Mode Output Voltage. Sets the output voltage <br> when DVS $=0$ through a GPI. |  |

## Buck Output Voltage Table

| $\begin{gathered} 0 \times 00= \\ 0.25000 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 20= \\ 0.41000 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 40= \\ 0.57000 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 60= \\ 0.73000 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 80= \\ 0.89000 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times \mathrm{AO} 0= \\ 1.05000 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times C 0= \\ 1.21000 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times E 0= \\ 1.37000 \mathrm{~V} \end{gathered}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\begin{gathered} 0 \times 01= \\ 0.25500 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 21= \\ 0.41500 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 41= \\ 0.57500 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 61= \\ 0.73500 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 81= \\ 0.89500 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times \mathrm{A} 1= \\ 1.05500 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times \mathrm{C} 1= \\ 1.21500 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times E 1= \\ 1.37500 \mathrm{~V} \end{gathered}$ |
| $\begin{gathered} 0 \times 02= \\ 0.26000 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 22= \\ 0.42000 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 42= \\ 0.58000 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 62= \\ 0.74000 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 82= \\ 0.90000 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times A 2= \\ 1.06000 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times C 2= \\ 1.22000 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times E 2= \\ 1.38000 \mathrm{~V} \end{gathered}$ |
| $\begin{gathered} 0 \times 03= \\ 0.26500 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 23= \\ 0.42500 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 43= \\ 0.58500 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 63= \\ 0.74500 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 83= \\ 0.90500 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times \mathrm{A} 3= \\ 1.06500 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times C 3= \\ 1.22500 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times E 3= \\ 1.38500 \mathrm{~V} \end{gathered}$ |
| $\begin{gathered} 0 \times 04= \\ 0.27000 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 24= \\ 0.43000 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 44= \\ 0.59000 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 64= \\ 0.75000 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 84= \\ 0.91000 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times \mathrm{A} 4= \\ 1.07000 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times C 4= \\ 1.23000 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times E 4= \\ 1.39000 \mathrm{~V} \end{gathered}$ |
| $\begin{gathered} 0 \times 05= \\ 0.27500 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 25= \\ 0.43500 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 45= \\ 0.59500 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 65= \\ 0.75500 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 85= \\ 0.91500 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times \mathrm{A} 5= \\ 1.07500 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times C 5= \\ 1.23500 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times E 5= \\ 1.39500 \mathrm{~V} \end{gathered}$ |
| $\begin{gathered} 0 \times 06= \\ 0.28000 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 26= \\ 0.44000 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 46= \\ 0.60000 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 66= \\ 0.76000 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 86= \\ 0.92000 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times \mathrm{A} 6= \\ 1.08000 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times C 6= \\ 1.24000 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times E 6= \\ 1.40000 \mathrm{~V} \end{gathered}$ |
| $\begin{gathered} 0 \times 07= \\ 0.28500 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 27= \\ 0.44500 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 47= \\ 0.60500 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 67= \\ 0.76500 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 87= \\ 0.92500 \mathrm{~V} \end{gathered}$ | $\begin{gathered} \hline 0 \times A 7= \\ 1.08500 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times C 7= \\ 1.24500 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times E 7= \\ 1.40500 \mathrm{~V} \end{gathered}$ |
| $\begin{gathered} 0 \times 08= \\ 0.29000 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 28= \\ 0.45000 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 48= \\ 0.61000 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 68= \\ 0.77000 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 88= \\ 0.93000 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times A 8= \\ 1.09000 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times C 8= \\ 1.25000 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times E 8= \\ 1.41000 \mathrm{~V} \end{gathered}$ |
| $\begin{gathered} 0 \times 09= \\ 0.29500 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 29= \\ 0.45500 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 49= \\ 0.61500 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 69= \\ 0.77500 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 89= \\ 0.93500 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times \mathrm{A} 9= \\ 1.09500 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times C 9= \\ 1.25500 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times E 9= \\ 1.41500 \mathrm{~V} \end{gathered}$ |
| $\begin{gathered} 0 \times 0 \mathrm{~A}= \\ 0.30000 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 2 \mathrm{~A}= \\ 0.46000 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 4 \mathrm{~A}= \\ 0.62000 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 6 \mathrm{~A}= \\ 0.78000 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 8 \mathrm{~A}= \\ 0.94000 \mathrm{~V} \end{gathered}$ | $\begin{gathered} \hline 0 \times A A= \\ 1.10000 \mathrm{~V} \end{gathered}$ | $\begin{gathered} \hline 0 \times C A= \\ 1.26000 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times \mathrm{XEA}= \\ 1.42000 \mathrm{~V} \end{gathered}$ |
| $\begin{gathered} 0 \times 0 \mathrm{~B}= \\ 0.30500 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 2 \mathrm{~B}= \\ 0.46500 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 4 \mathrm{~B}= \\ 0.62500 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 6 \mathrm{~B}= \\ 0.78500 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 8 \mathrm{~B}= \\ 0.94500 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times A B= \\ 1.10500 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times C B= \\ 1.26500 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times E B= \\ 1.42500 \mathrm{~V} \end{gathered}$ |
| $\begin{gathered} 0 \times 0 \mathrm{C}= \\ 0.31000 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 2 \mathrm{C}= \\ 0.47000 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 4 \mathrm{C}= \\ 0.63000 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 6 \mathrm{C}= \\ 0.79000 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 8 \mathrm{C}= \\ 0.95000 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times A C= \\ 1.11000 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times C C= \\ 1.27000 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times E C= \\ 1.43000 \mathrm{~V} \end{gathered}$ |
| $\begin{gathered} 0 \times 0 \mathrm{D}= \\ 0.31500 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 2 \mathrm{D}= \\ 0.47500 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 4 \mathrm{D}= \\ 0.63500 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 6 \mathrm{D}= \\ 0.79500 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 8 \mathrm{D}= \\ 0.95500 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times A D= \\ 1.11500 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times C D= \\ 1.27500 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times E D= \\ 1.43500 \mathrm{~V} \end{gathered}$ |

## Buck Output Voltage Table (continued)

| $\begin{gathered} 0 \times 0 \mathrm{E}= \\ 0.32000 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 2 \mathrm{E}= \\ 0.48000 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 4 \mathrm{E}= \\ 0.64000 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 6 \mathrm{E}= \\ 0.80000 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 8 \mathrm{E}= \\ 0.96000 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times A E= \\ 1.12000 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times C E= \\ 1.28000 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times E E= \\ 1.44000 \mathrm{~V} \end{gathered}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\begin{gathered} 0 \times 0 F= \\ 0.32500 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 2 \mathrm{~F}= \\ 0.48500 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 4 \mathrm{~F}= \\ 0.64500 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 6 \mathrm{~F}= \\ 0.80500 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 8 \mathrm{~F}= \\ 0.96500 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times A F= \\ 1.12500 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times C F= \\ 1.28500 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times E F= \\ 1.44500 \mathrm{~V} \end{gathered}$ |
| $\begin{gathered} 0 \times 10= \\ 0.33000 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 30= \\ 0.49000 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 50= \\ 0.65000 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 70= \\ 0.81000 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 90= \\ 0.97000 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times B 0= \\ 1.13000 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times D 0= \\ 1.29000 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times F 0= \\ 1.45000 \mathrm{~V} \end{gathered}$ |
| $\begin{gathered} 0 \times 11= \\ 0.33500 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 31= \\ 0.49500 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 51= \\ 0.65500 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 71= \\ 0.81500 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 91= \\ 0.97500 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times B 1= \\ 1.13500 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times D 1= \\ 1.29500 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times F 1= \\ 1.45500 \mathrm{~V} \end{gathered}$ |
| $\begin{gathered} 0 \times 12= \\ 0.34000 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 32= \\ 0.50000 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 52= \\ 0.66000 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 72= \\ 0.82000 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 92= \\ 0.98000 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times B 2= \\ 1.14000 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times D 2= \\ 1.30000 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 52= \\ 1.46000 \mathrm{~V} \end{gathered}$ |
| $\begin{gathered} 0 \times 13= \\ 0.34500 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 33= \\ 0.50500 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 53= \\ 0.66500 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 73= \\ 0.82500 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 93= \\ 0.98500 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times B 3= \\ 1.14500 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times D 3= \\ 1.30500 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 53= \\ 1.46500 \mathrm{~V} \end{gathered}$ |
| $\begin{gathered} 0 \times 14= \\ 0.35000 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 34= \\ 0.51000 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 54= \\ 0.67000 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 74= \\ 0.83000 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 94= \\ 0.99000 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times B 4= \\ 1.15000 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times D 4= \\ 1.31000 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 54= \\ 1.47000 \mathrm{~V} \end{gathered}$ |
| $\begin{gathered} 0 \times 15= \\ 0.35500 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 35= \\ 0.51500 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 55= \\ 0.67500 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 75= \\ 0.83500 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 95= \\ 0.99500 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times B 5= \\ 1.15500 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times D 5= \\ 1.31500 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 55= \\ 1.47500 \mathrm{~V} \end{gathered}$ |
| $\begin{gathered} 0 \times 16= \\ 0.36000 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 36= \\ 0.52000 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 56= \\ 0.68000 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 76= \\ 0.84000 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 96= \\ 1.00000 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times B 6= \\ 1.16000 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times D 6= \\ 1.32000 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 56= \\ 1.48000 \mathrm{~V} \end{gathered}$ |
| $\begin{gathered} 0 \times 17= \\ 0.36500 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 37= \\ 0.52500 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 57= \\ 0.68500 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 77= \\ 0.84500 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 97= \\ 1.00500 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times B 7= \\ 1.16500 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times D 7= \\ 1.32500 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times F 7= \\ 1.48500 \mathrm{~V} \end{gathered}$ |
| $\begin{gathered} 0 \times 18= \\ 0.37000 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 38= \\ 0.53000 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 58= \\ 0.69000 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 78= \\ 0.85000 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 98= \\ 1.01000 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times B 8= \\ 1.17000 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times D 8= \\ 1.33000 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 58= \\ 1.49000 \mathrm{~V} \end{gathered}$ |
| $\begin{gathered} 0 \times 19= \\ 0.37500 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 39= \\ 0.53500 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 59= \\ 0.69500 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 79= \\ 0.85500 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 99= \\ 1.01500 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times B 9= \\ 1.17500 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times D 9= \\ 1.33500 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 59= \\ 1.49500 \mathrm{~V} \end{gathered}$ |
| $\begin{gathered} 0 \times 1 \mathrm{~A}= \\ 0.38000 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 3 \mathrm{~A}= \\ 0.54000 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 5 \mathrm{~A}= \\ 0.70000 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 7 \mathrm{~A}= \\ 0.86000 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 9 \mathrm{~A}= \\ 1.02000 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times B A= \\ 1.18000 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times D A= \\ 1.34000 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times x A= \\ 1.50000 \mathrm{~V} \end{gathered}$ |
| $\begin{gathered} 0 \times 1 \mathrm{~B}= \\ 0.38500 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 3 \mathrm{~B}= \\ 0.54500 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 5 \mathrm{~B}= \\ 0.70500 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 7 \mathrm{~B}= \\ 0.86500 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 9 \mathrm{~B}= \\ 1.02500 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times B B= \\ 1.18500 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times D B= \\ 1.34500 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times F B= \\ 1.50500 \mathrm{~V} \end{gathered}$ |
| $\begin{gathered} 0 \times 1 \mathrm{C}= \\ 0.39000 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 3 \mathrm{C}= \\ 0.55000 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 5 \mathrm{C}= \\ 0.71000 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 7 \mathrm{C}= \\ 0.87000 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 9 \mathrm{C}= \\ 1.03000 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times B C= \\ 1.19000 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times D C= \\ 1.35000 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times F C= \\ 1.51000 \mathrm{~V} \end{gathered}$ |
| $\begin{gathered} 0 \times 1 \mathrm{D}= \\ 0.39500 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 3 \mathrm{D}= \\ 0.55500 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 5 \mathrm{D}= \\ 0.71500 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 7 \mathrm{D}= \\ 0.87500 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 9 \mathrm{D}= \\ 1.03500 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times B D= \\ 1.19500 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times D D= \\ 1.35500 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times F D= \\ 1.51500 \mathrm{~V} \end{gathered}$ |
| $\begin{gathered} 0 \times 1 \mathrm{E}= \\ 0.40000 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 3 E= \\ 0.56000 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 5 \mathrm{E}= \\ 0.72000 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 7 \mathrm{E}= \\ 0.88000 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 9 \mathrm{E}= \\ 1.04000 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times B E= \\ 1.20000 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times D E= \\ 1.36000 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times F E= \\ 1.52000 \mathrm{~V} \end{gathered}$ |
| $\begin{gathered} 0 \times 1 F= \\ 0.40500 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 3 F= \\ 0.56500 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 5 \mathrm{~F}= \\ 0.72500 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 7 \mathrm{~F}= \\ 0.88500 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times 9 \mathrm{~F}= \\ 1.04500 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times B F= \\ 1.20500 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times D F= \\ 1.36500 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 0 \times x F= \\ 1.52500 \mathrm{~V} \end{gathered}$ |

## M1_CFG BUCK Master 1 Configuration Register

| ADDRESS | MODE |  | TYPE: 0 | RESET VALUE: 0xD1 |
| :---: | :---: | :---: | :---: | :---: |
| 0x2F | R/W |  |  |  |
| BIT | NAME | POR | DESCRIPTION |  |
| 7 | M1_AD | 1 | BUCK Master 1 Output Active Discharge <br> 0: Disable <br> 1: Enable |  |
| 6:4 | M1_ILIM[2:0] | 101 | BUCK Master 1 PMOS Peak/NMOS Valley Current Limit Setting <br> 000b: 3.0A/2.0A <br> 001b: 3.6A/2.4A <br> 010b: 4.2A/2.8A <br> 011b: 4.8A/3.2A <br> 100b: 5.4A/3.6A <br> 101b: 6.0A/4.0A <br> 110b: 6.6A/4.4A <br> 111b: 7.2A/4.8A |  |
| 2:3 | RESERVED | 00 | Write '00' |  |
| 1 | M1_FPWM | 0 | BUCK Master 1 Forced PWM <br> 0: Turn off Forced PWM (Automatic skip mode operation under light load) 1: Turn on Forced PWM mode |  |
| 0 | M1_FSREN | 1 | BUCK Master 1 Falling Slew Rate Control <br> 0: Disable <br> BUCK Master 1 operates in skip mode during the output voltage rampdown (only if M1_FPWM = 0). In skip mode, negative current through the low-side FET is not allowed so that the output voltage falling slew rate is a function of the output capacitance and the external load under light load condition. If the load is heavy, the output voltage falling slew rate is limited to the ramp-down slew rate set by B_RD_SR[1:0]. Note that the internal feedback string always imposes a $2 \mu \mathrm{~A}$ load on the output. <br> 1: Enable <br> BUCK Master 1 operates in Forced PWM mode during the output voltage ramp-down. In Forced PWM mode, BUCK Master 1 can sink current from the output capacitor to ensure that the output voltage decreases at the ramp-down slew rate set by B_RD_SR[1:0]. To ensure a smooth output voltage ramp-down, Forced PMW mode remains engaged for $50 \mu$ s after the output voltage decreases to its target voltage. |  |

## M2_CFG BUCK Master 2 Configuration Register

| ADDRESS | MODE |  | TYPE: 0 | RESET VALUE: 0xD1 |
| :---: | :---: | :---: | :---: | :---: |
| 0x30 | R/W |  |  |  |
| BIT | NAME | POR | DESCRIPTION |  |
| 7 | M2_AD | 1 | BUCK Master 2 Output Active Discharge <br> 0: Disable <br> 1: Enable |  |
| 6:4 | M2_ILIM[2:0] | 101 | BUCK Master 2 PMOS Peak/NMOS Valley Current Limit Setting <br> 000b: 3.0A/2.0A <br> 001b: 3.6A/2.4A <br> 010b: 4.2A/2.8A <br> 011b: 4.8A/3.2A <br> 100b: 5.4A/3.6A <br> 101b: 6.0A/4.0A <br> 110b: 6.6A/4.4A <br> 111b: 7.2A/4.8A |  |
| 2:3 | RESERVED | 00 | Write '00' |  |
| 1 | M2_FPWM | 0 | BUCK Master 2 Forced PWM <br> 0: Turn off Forced PWM (Automatic skip mode operation under light load) <br> 1: Turn on Forced PWM mode |  |
| 0 | M2_FSREN | 1 | BUCK Master 2 Falling Slew Rate Control <br> 0: Disable <br> BUCK Master 2 operates in skip mode during the output voltage ramp-down (only if M2_FPWM = 0). In skip mode, negative current through the low-side FET is not allowed so that the output voltage falling slew rate is a function of the output capacitance and the external load under light load condition. If the load is heavy, the output voltage falling slew rate is limited to the ramp-down slew rate set by B_RD_SR[1:0]. Note that the internal feedback string always imposes a $2 \mu \mathrm{~A}$ load on the output. <br> 1: Enable <br> BUCK Master 2 operates in Forced PWM mode during the output voltage ramp-down. In Forced PWM mode, BUCK Master 2 can sink current from the output capacitor to ensure that the output voltage decreases at the ramp-down slew rate set by B_RD_SR[1:0]. To ensure a smooth output voltage ramp-down, Forced PMW mode remains engaged for $50 \mu$ s after the output voltage decreases to its target voltage. |  |

## M3_CFG BUCK Master 3 Configuration Register

| ADDRESS | MODE |  | TYPE: 0 | RESET VALUE: 0xD1 |
| :---: | :---: | :---: | :---: | :---: |
| 0x31 | R/W |  |  |  |
| BIT | NAME | POR |  | RIPTION |
| 7 | M3_AD | 1 | BUCK Master 3 Output Active Discharge <br> 0: Disable <br> 1: Enable |  |
| 6:4 | M3_ILIM[2:0] | 101 | BUCK Master 3 PMOS Peak/NMOS Valley Current Limit Setting <br> 000b: 3.0A/2.0A <br> 001b: 3.6A/2.4A <br> 010b: 4.2A/2.8A <br> 011b: 4.8A/3.2A <br> 100b: 5.4A/3.6A <br> 101b: 6.0A/4.0A <br> 110b: 6.6A/4.4A <br> 111b: 7.2A/4.8A |  |
| 2:3 | RESERVED | 00 | Write '00' |  |
| 1 | M3_FPWM | 0 | BUCK Master 3 Forced PWM <br> 0: Turn off Forced PWM (Automatic skip mode operation under light load) 1: Turn on Forced PWM mode |  |
| 0 | M3_FSREN | 1 | BUCK Master 3 Falling Slew Rate Control <br> 0: Disable <br> BUCK Master 3 operates in skip mode during the output voltage ramp-down (only if M3_FPWM = 0). In skip mode, negative current through the low-side FET is not allowed so that the output voltage falling slew rate is a function of the output capacitance and the external load under light load condition. If the load is heavy, the output voltage falling slew rate will be limited to the ramp-down slew rate set by B_RD_SR[1:0]. Note that the internal feedback string always imposes a $2 \mu \mathrm{~A}$ load on the output. <br> 1: Enable <br> BUCK Master 3 operates in Forced PWM mode during the output voltage ramp-down. In Forced PWM mode, BUCK Master 3 can sink current from the output capacitor to ensure that the output voltage decreases at the ramp-down slew rate set by B_RD_SR[1:0]. To ensure a smooth output voltage ramp-down, Forced PMW mode remains engaged for $50 \mu$ s after the output voltage decreases to its target voltage. |  |

## M4_CFG BUCK Master 4 Configuration Register

| ADDRESS | MODE |  | TYPE: O | RESET VALUE: 0xD1 |
| :---: | :---: | :---: | :---: | :---: |
| 0x32 | R/W |  |  |  |
| BIT | NAME | POR | DESCRIPTION |  |
| 7 | M4_AD | 1 | BUCK Master 4 Output Active Discharge <br> 0: Disable <br> 1: Enable |  |
| 6:4 | M4_ILIM[2:0] | 101 | BUCK Master 4 PMOS Peak/NMOS Valley Current Limit Setting <br> 000b: 3.0A/2.0A <br> 001b: 3.6A/2.4A <br> 010b: 4.2A/2.8A <br> 011b: 4.8A/3.2A <br> 100b: 5.4A/3.6A <br> 101b: 6.0A/4.0A <br> 110b: 6.6A/4.4A <br> 111b: 7.2A/4.8A |  |
| 2:3 | RESERVED | 00 | Write '00' |  |
| 1 | M4_FPWM | 0 | BUCK Master4 Forced PWM <br> 0: Turn off Forced PWM (Automatic skip mode operation under light load) <br> 1: Turn on Forced PWM mode |  |
| 0 | M4_FSREN | 1 | BUCK Master 4 Falling Slew Rate Control <br> 0: Disable <br> BUCK Master 4 operates in skip mode during the output voltage rampdown (only if M4_FPWM = 0). In skip mode, negative current through the low-side FET is not allowed so that the output voltage falling slew rate is a function of the output capacitance and the external load under light load condition. If the load is heavy, the output voltage falling slew rate is limited to the ramp-down slew rate set by B_RD_SR[1:0]. Note that the internal feedback string always imposes a $2 \mu \mathrm{~A}$ load on the output. <br> 1: Enable <br> BUCK Master 4 operates in Forced PWM mode during the output voltage ramp-down. In Forced PWM mode, BUCK Master 4 can sink current from the output capacitor to ensure that the output voltage decreases at the ramp-down slew rate set by B_RD_SR[1:0]. To ensure a smooth output voltage ramp-down, Forced PMW mode remains engaged for $50 \mu$ s after the output voltage decreases to its target voltage. |  |

## GLB_CFG1 BUCK Global Configuration Register 1

| ADDRESS | MODE |  | TYPE: 0 | RESET VALUE: 0x24 |
| :---: | :---: | :---: | :---: | :---: |
| 0x33 | R/W |  |  |  |
| BIT | NAME | POR | DESCRIPTION |  |
| 7 | RESERVED | 0 |  |  |
| 6:4 | B_SD_SR[2:0] | 010 | Shutdown Slew Rate 000b: $1.25 \mathrm{mV} / \mathrm{\mu s}$ 001b: $2.5 \mathrm{mV} / \mu \mathrm{s}$ 010b: $5 \mathrm{mV} / \mu \mathrm{s}$ 011b: $10 \mathrm{mV} /$ /s 100b: $20 \mathrm{mV} /$ / 101b: $40 \mathrm{mV} /$ /us 110b: $60 \mathrm{mV} / \mathrm{\mu s}$ 111b: $60 \mathrm{mV} / \mu \mathrm{s}$ |  |
| 3 | RESERVED | 0 |  |  |
| 0:2 | B_SS_SR[2:0] | 100 | Soft Start Slew Rate 000b: $1.25 \mathrm{mV} / \mathrm{\mu s}$ 001b: $2.5 \mathrm{mV} / \mu \mathrm{s}$ 010b: $5 \mathrm{mV} / \mu \mathrm{s}$ 011b: $10 \mathrm{mV} / \mathrm{\mu s}$ 100b: $20 \mathrm{mV} /$ /us 101b: $40 \mathrm{mV} /$ /us 110b: $60 \mathrm{mV} / \mu \mathrm{s}$ 111b: $60 \mathrm{mV} / \mu \mathrm{s}$ |  |

## GLB_CFG2 BUCK Global Configuration Register 2

| ADDRESS | MODE |  | TYPE: 0 | RESET VALUE: 0x24 |
| :---: | :---: | :---: | :---: | :---: |
| 0x34 | R/W |  |  |  |
| BIT | NAME | POR | DESCRIPTION |  |
| 7 | RESERVED | 0 |  |  |
| 6:4 | B_RD_SR[2:0] | 010 | Ramp-Down Slew Rate 000b: $1.25 \mathrm{mV} / \mu \mathrm{s}$ 001b: $2.5 \mathrm{mV} / \mu \mathrm{s}$ 010b: $5 \mathrm{mV} / \mu \mathrm{s}$ 011b: $10 \mathrm{mV} /$ us 100b: $20 \mathrm{mV} /$ / 101b: $40 \mathrm{mV} /$ / s 110b: $60 \mathrm{mV} / \mu \mathrm{s}$ 111b: $60 \mathrm{mV} / \mu \mathrm{s}$ |  |
| 3 | RESERVED | 0 |  |  |
| 0:2 | B_RU_SR[2:0] | 100 | Ramp-Up Slew Rate 000b: $1.25 \mathrm{mV} / \mu \mathrm{s}$ 001b: $2.5 \mathrm{mV} / \mu \mathrm{s}$ 010b: $5 \mathrm{mV} / \mu \mathrm{s}$ 011b: $10 \mathrm{mV} /$ us 100b: $20 \mathrm{mV} /$ /s 101b: $40 \mathrm{mV} / \mathrm{\mu s}$ 110b: $60 \mathrm{mV} /$ /s 111b: $60 \mathrm{mV} / \mu \mathrm{s}$ |  |

## GLB_CFG3 BUCK Global Configuration Register 3

| ADDRESS | MODE |  | TYPE: $\mathbf{O}$ |  |
| :---: | :---: | :---: | :---: | :---: |
| $\mathbf{0 x 3 5}$ | R/W | RESET VALUE: 0x5F |  |  |
| BIT | NAME | POR |  |  |
| 7 | RESERVED | 0 |  |  |
| 6 | RESERVED | 1 |  |  |
| 5 | RESERVED | 0 |  |  |
| 4 | RESERVED | 1 |  |  |
| 3 | RESERVED | 1 |  |  |
| 2 | RESERVED | 1 |  |  |
| 1 | B_PETR_EN | 1 | Positive Enhanced Transient Response Control <br> 0: Disable <br> 1: Enable |  |
| 0 | B_NETR_EN | 1 | Negative Enhanced Transient Response Control <br> 0: Disable <br> 1: Enable |  |

0x36-0xFF: RESERVED

## PCB Layout Guidelines

Careful circuit board layout is critical to low-power switching losses and clean stable operation.

For more details on PCB layout recommendations for the MAX77812, refer to Application Note 6819: MAX77812 PCB Layout Guide.

Simplified Block Diagram


## Ordering Information

| PART | DEFAULT OUTPUT VOLTAGE (V) |  |  |  | STARTUP DELAY TIME (ms) |  |  | ${ }^{12}{ }^{2} \mathrm{C}$ SLAVE ADDRESS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | M1_VOUT | M2_VOUT | M3_VOUT | M4_VOUT | $\begin{gathered} \text { M2_STUP } \\ \text { _DLY } \end{gathered}$ | $\begin{gathered} \text { M3_STUP } \\ \text { _DLY } \end{gathered}$ | $\begin{gathered} \text { M4_STUP } \\ \text { _DLY } \end{gathered}$ |  |
| MAX77812EWB+T | 0.650 | 0.650 | 0.600 | 0.600 | 0 | 0 | 0 | 0x60-0x69 |
| MAX77812AEWB+T | 0.700 | 0.700 | 0.800 | 1.100 | 0 | 0 | 2 | 0x60-0x69 |
| MAX77812BEWB+T | 1.120 | 1.120 | 0.920 | 0.950 | 0 | 0 | 0 | 0x60-0x69 |
| MAX77812CEWB+T | 0.720 | 1.495 | 0.820 | 0.820 | 5 | 1 | 3 | 0x60-0x69 |
| MAX77812DEWB+T | 0.720 | 1.200 | 0.900 | 0.750 | 3 | 6 | 9 | 0x60-0x69 |
| MAX77812FEWB+T | 0.620 | 1.100 | 0.900 | 1.495 | 0 | 0 | 0 | 0x70-0x79 |

+Denotes a lead(Pb)-free/RoHS-compliant package.
$T$ = Tape and reel.

## Package Information

For the latest package outline information and land patterns (footprints), go to www.maximintegrated.com/packages. Note that a " + ", "\#", or "-" in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

| PACKAGE TYPE | PACKAGE CODE | OUTLINE NO. | LAND PATTERN NO. |
| :---: | :---: | :---: | :---: |
| 64 WLP | W643C3+1 | $\underline{21-100087}$ | Refer to <br> Application Note 1891: |
| Wafer-Level Packaging |  |  |  |
| $($ WLP) and Its Applications |  |  |  |

Revision History

| REVISION NUMBER | REVISION <br> DATE | DESCRIPTION | PAGES CHANGED |
| :---: | :---: | :---: | :---: |
| 0 | 6/16 | Initial release | - |
| 1 | 3/17 | Updated Applications section, updated Benefits and Features section, updated MIN/TYP/MAX values in the Electrical Characteristics section and changed inductor to $220 \mathrm{nH}, \mathrm{DCR}=16 \mathrm{~m} \Omega$, added Cyntec information to Table 2, added ${ }^{2} \mathrm{C}$ slave addresses for OTP $=1$ to Table 5, updated Figures 6-9 and communication protocols description, updated GPI_FUNC, M1_CFG, M2_CFG, M3_CFG, M4_CFG, GLB_CFG1, GLB_CFG2 registers in the Register Map table, updated Typical Application Circuit | $\begin{gathered} 1-14,29, \\ 32-36,42,43, \\ 49,56,60-66 \end{gathered}$ |
| 2 | 6/17 | Updated Benefits and Features section and Register Map table, fixed various typos | $\begin{gathered} 1,2,4-6,8,11,12, \\ 14,15,23,25,26 \\ 31,33-38,42,43 \\ 46-48,62-64 \end{gathered}$ |
| 3 | 8/17 | Updated title, Benefits and Features section, and Electrical Characteristics table, corrected label error to Output Voltage Error (\%) in Typical Operating Characteristics, corrected errors to register name and removed error statement in HS mode in Detailed Description section, removed inductor from Table 2, corrected error in POR bits in the GPI_PD_CTRL GPI Pulldown Resistor Control Register table | $\begin{gathered} 1,10,14,16,26 \\ 29,30,38,51 \end{gathered}$ |
| 4 | 1/18 | Updated Applications and Benefits and Features sections, added Simplified Block Diagram, added LX1/2/3/4 pulsed ratings, updated Electrical Characteristics tables, updated Detailed Description section, added ALPS 220 nH , removed process information | $\begin{gathered} 1-4,11,15 \\ 26-29,30,31,38 \\ 67 \end{gathered}$ |
| 5 | 5/18 | Updated General Description, Benefits and Features, and Applications sections, renamed Typical Application Circuit and moved to page 1, updated Absolute Maximum Ratings for LXx RMS current, updated Electrical Characteristics tables, updated Typical Operating Characteristics global conditions and TOCs, updated Detailed Description sections, Table 1, Figure 2, Table 5, corrected errors in Registers information, renamed Simplified Block Diagram and updated to $2+1+1$ configuration, updated Ordering Information table | $\begin{gathered} 1-3,14,16,17, \\ 26,28-30,32,34, \\ 35,47-50,59-62, \\ 66,67 \end{gathered}$ |
| 6 | 7/18 | Corrected typo in Electrical Characteristics table and other sections, updated Ordering Information table | $\begin{gathered} 1,13,22,24-43 \\ 53,63,65 \end{gathered}$ |
| 7 | 6/19 | Updated Table 5 and Ordering Information table | 32, 65 |
| 8 | 8/19 | Updated Typical Operating Characteristics global conditions and TOCs, corrected label error to Output Voltage Error (\%) in Typical Operating Characteristics, updated Output Voltage Setting section, added Enhanced Transient Response section, and added PCB Layout Guidelines section | 14-15, 28-29, 63 |
| 9 | 9/19 | Updated Typical Operating Characteristics section | 14-22 |

Revision History (continued)

| REVISION NUMBER | REVISION DATE | DESCRIPTION | PAGES CHANGED |
| :---: | :---: | :---: | :---: |
| 10 | 4/20 | Updated Startup and Shutdown Sequence section, Phase/Output Configurations section, Multifunction GPIs General Description section, Register Map table, M1_VOUT_D, M2_VOUT_D, M3_VOUT_D, M4_VOUT_D, M1_VOUT_S, M2_VOUT_S, M3_VOUT_S, and M4_VOUT_S register descriptions, and GLB_ CFG3 BUCK Global Configuration Register 3 table; added Inductor Current Limit section and Unused Outputs section | $\begin{gathered} 27-28,31-32,45 \\ 56-57,65 \end{gathered}$ |
| 11 | 12/20 | Updated Absolute Maximum Ratings section, added Recommended Operating Conditions table, and updated global conditions in Electrical Characteristics tables | 1-13 |
| 12 | 10/22 | Updated Undervoltage Lockout and Output Voltage Setting sections, added Power-OK (POK) section | 26, 29, 31 |


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[^1]:    *RW: Read and write
    R: Read only
    R/C: Read and clear

[^2]:    0x14: RESERVED

